



KOMMISSION DER EUROPÄISCHEN GEMEINSCHAFTEN

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Vorschlag für einen

BESCHLUSS DES RATES

**über die Beseitigung der Zölle auf Waren der Informationstechnologie**

Vorschlag für einen

BESCHLUSS DES RATES

**über die Beseitigung der Zölle auf bestimmte Spirituosen**

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(von der Kommission vorgelegt)



## BEGRÜNDUNG

Auf seiner Sondertagung am 13. Dezember 1996 in Singapur billigte der Rat **zum einen** eine Ministererklärung über den Handel mit Waren der Informationstechnologie und begrüßte **zum anderen** die mit den Vereinigten Staaten von Amerika erzielte bilaterale Vereinbarung (unter Genehmigungsvorbehalt), der zufolge die Zölle auf sogenannte "braune" Spirituosen schneller abgebaut werden sollen, als dies in der Uruguay-Runde vereinbart wurde, und auch die Zölle auf andere Spirituosen beseitigt werden sollen.

Im Zusammenhang mit dem **Übereinkommen über die Informationstechnologie (ITA)** ist daran zu erinnern, daß am 3. Dezember 1995 auf dem Gipfeltreffen EU-USA eine Neue Transatlantische Agenda unterzeichnet wurde, in der beide Seiten unter anderem erklärten: "*Angesichts der Bedeutung der Informationsgesellschaft leiten wir eine spezifische Maßnahme in die Wege, um zu versuchen, ein Übereinkommen über die Informationstechnologie zu schließen.*" Auf der parallelen Tagung des Transatlantischen Unternehmerdialogs wurde diese politische Verpflichtung bekräftigt, indem die Teilnehmer feststellten: "Die überwältigende Mehrheit ist der Ansicht, daß das ITA-Paket die Verpflichtung beinhalten sollte, alle Zölle spätestens bis zum Januar 2000 zu beseitigen".

Nach Sondierungsgesprächen mit mehreren Drittländern und Erörterungen im Ausschuß nach Artikel 113 EG-Vertrag schlug die Kommission dem Rat am 22. Oktober 1996 die Annahme eines Beschlusses vor, um Verhandlungen mit Drittländern über den Abschluß eines Übereinkommens über die Informationstechnologie aufzunehmen. Der Rat faßte den entsprechenden Beschluß am 15. November 1996.

Die plurilateralen Verhandlungen führten am 13. Dezember 1996 in Singapur zur Annahme einer Ministererklärung, in der 15 WTO-Mitglieder bzw. beitrittswillige Staaten/Zollgebiete (Australien, Kanada, Taiwan, Europäische Gemeinschaften, Hongkong, Island, Indonesien, Japan, Korea, Liechtenstein, Norwegen, Singapur, Schweiz, Türkei, Vereinigte Staaten von Amerika) die Beseitigung der Zölle auf die in den Anlagen genannten Waren der Informationstechnologie bis zum Jahr 2000 (in vier

gleichen Raten) vereinbarten. In diesem Zusammenhang ist insbesondere auf Absatz 4 der Modalitäten im Anhang zur Erklärung hinzuweisen:

“4. Die Teilnehmer kommen so bald wie möglich und in jedem Fall spätestens am 1. April 1997 zusammen, um die eingegangenen Annahmeerklärungen zu überprüfen und die daraus zu ziehenden Schlüsse zu beurteilen. Die Teilnehmer setzen die in der Erklärung vorgesehenen Aktionen um, sofern bis dahin so viele Länder ihre Annahme notifiziert haben, daß ungefähr 90 % des Welthandels<sup>1</sup> mit Waren der Informationstechnologie erfaßt werden und sofern die Abfolge der Senkungen zur Zufriedenheit der Teilnehmer vereinbart wurde. Bei der Prüfung der Frage, ob die in der Erklärung vorgesehenen Aktionen auch dann umzusetzen sind, wenn der Anteil der Teilnehmer am Welthandel mit Waren der Informationstechnologie leicht unter 90 % liegt, können die Teilnehmer auch berücksichtigen, in welchem Maße Staaten oder gesonderte Zollgebiete teilnehmen, mit denen sie den wesentlichen Anteil ihres Handels mit diesen Waren abwickeln. Auf dieser Tagung legen die Teilnehmer fest, ob diese Kriterien erfüllt sind.”

Am 31. Januar 1997 wurden die im Rahmen der Ministererklärung vorgesehenen plurilateralen technischen Gespräche abgeschlossen. Zwar wurde die Liste der einzubeziehenden Waren erörtert, doch wurden die ursprünglichen Anlagen zur Ministererklärung nicht geändert. Die Gesprächsteilnehmer kamen überein, die erste Runde von Konsultationen über die Einbeziehung weiterer Waren am 1. Oktober 1997 aufzunehmen; gleichzeitig wurde (unter Genehmigungsvorbehalt) Einvernehmen über die von einigen ursprünglichen Unterzeichnern der Ministererklärung beantragte “zeitliche Streckung” der Zollsenkungen erzielt. Dies betraf Indonesien, Korea und Taiwan. Außerdem wurde die Ministererklärung auch von Neuseeland (das keine “besondere Abfolge der Zollsenkungen” beantragte) und Costa Rica (dessen Antrag auf “besondere Abfolge der Zollsenkungen” zuvor von den übrigen Teilnehmern gebilligt wurde) angenommen.

Gemäß den Schlußfolgerungen des Rates auf der Sondertagung vom 13. Dezember 1996 in Singapur muß vor der Prüfung der Unterlagen der Teilnehmer, die spätestens bis zum 1. April 1997 abzuschließen ist, ein Ratsbeschluß ergehen, um das Übereinkommen endgültig und rechtsverbindlich für die Gemeinschaft zu genehmigen. Dieser Beschluß hängt davon ab, daß der vereinbarte Prozentsatz des Welthandels mit Waren der Informationstechnologie vom Übereinkommen erfaßt wird und Einvernehmen über die

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<sup>1</sup> Dieser Prozentsatz wird vom WTO-Sekretariat auf der Grundlage der zum Zeitpunkt des Treffens neuesten Daten ermittelt.

“zeitliche Abfolge” der Zolllenkungen erzielt wird. Bei dem beiliegenden Beschlußentwurf wird davon ausgegangen, daß beide Kriterien erfüllt werden. Sollte dies bis Ende März nicht der Fall sein, müßte die Angelegenheit überprüft werden.

Im Bereich der Spirituosen verbessert die Vereinbarung mit den Vereinigten Staaten von Amerika nach Auffassung der Kommission spürbar die Exportchancen der EU. Die Kommission wird sich weiterhin darum bemühen, auch andere Parteien in diese Vereinbarung einzubeziehen.

Auf dieser Grundlage übermittelt die Kommission dem Rat die beiliegenden zwei Beschlußentwürfe.

## **Vorschlag**

**Beschluß des Rates**

**97/0082 (ACC)**

### **über die Beseitigung der Zölle auf Waren der Informationstechnologie**

**DER RAT DER EUROPÄISCHEN UNION -**

gestützt auf den Vertrag zur Gründung der Europäischen Gemeinschaft, insbesondere auf Artikel 113 in Verbindung mit Artikel 228 Absatz 2 Satz 1,

auf Vorschlag der Kommission,

in Erwägung nachstehender Gründe:

In der Neuen Transatlantischen Agenda, die auf dem Gipfeltreffen EU-USA am 13. Dezember 1995 in Madrid angenommen wurde, vereinbarten beide Seiten zu versuchen, ein Übereinkommen über die Informationstechnologie zu schließen.

Nach Berichten der Kommission über ihre Sondierungsgespräche mit Drittländern beschloß der Rat am 16. November 1996 die Aufnahme von Verhandlungen mit Drittländern über den Abschluß eines Übereinkommens über die Informationstechnologie.

Am 13. Dezember 1996 billigte die Europäische Gemeinschaft in Singapur die Ministererklärung über den Handel mit Waren der Informationstechnologie. In dieser Erklärung sind bestimmte Voraussetzungen für die Beseitigung der Zölle auf Waren der Informationstechnologie festgelegt. Diese Voraussetzungen sind erfüllt -

**BESCHLIESST:**

### *Artikel 1*

Das Übereinkommen in Form der am 13. Dezember 1996 in Singapur abgegebenen Ministererklärung über den Handel mit Waren der Informationstechnologie wird im Namen der Gemeinschaft genehmigt.

Der Wortlaut des Übereinkommens ist diesem Beschluß beigelegt.

### *Artikel 2*

Gemäß Absatz 4 des Anhangs zur Ministererklärung:

(i) nimmt der Rat zur Kenntnis, daß Teilnehmer, auf die ungefähr 90 % des Welthandels mit Waren der Informationstechnologie entfallen, ihre Annahme notifiziert haben, und

(ii) genehmigt im Namen der Gemeinschaft die von bestimmten Teilnehmern beantragte Abfolge der Zollsenkungen.

### *Artikel 3*

Der Rat ermächtigt die Kommission, der Welthandelsorganisation die im Anhang beigelegten Änderungen der Liste der Europäischen Gemeinschaft zu übermitteln, um die betreffenden Zölle im Einklang mit der Ministererklärung zu binden und zu beseitigen.

### *Artikel 4*

Der Präsident des Rates wird ermächtigt, die Person zu bestellen, die befugt ist, das Übereinkommen/Protokoll rechtsverbindlich für die Gemeinschaft zu unterzeichnen.

Geschehen zu Brüssel

Im Namen des Rates

Der Präsident

~~CONFIDENTIAL~~

**MINISTERERKLÄRUNG ÜBER DEN HANDEL MIT WAREN**  
**DER INFORMATIONSTECHNOLOGIE**

13.12.1996

*Die Minister -*

*in Vertretung* der folgenden Mitglieder der Welthandelsorganisation (WTO) und der Staaten und gesonderten Zollgebiete auf dem Weg des Beitritts zur WTO, die in Singapur die weltweite Ausweitung des Handels mit Waren der Informationstechnologie vereinbart haben und die weit mehr als [80] Prozent des weltweiten Handels mit diesen Waren auf sich vereinen (im folgenden "Vertragsparteien" genannt):

Australien	Japan
Kanada	Korea
Taiwan	Norwegen
Europäische Gemeinschaften	Singapur
Hongkong	Schweiz <sup>1</sup>
Island	Türkei
Indonesien	Vereinigte Staaten

*in Anbetracht* der wesentlichen Rolle des Handels mit Waren der Informationstechnologie für die Entwicklung der Informationsindustrie und für das dynamische Wachstum der Weltwirtschaft;

*in Anerkennung* des Ziels, den Lebensstandard zu erhöhen und die Produktion von Waren sowie den Handel mit ihnen auszuweiten;

*in dem Wunsch*, die größtmögliche Freiheit im Handel mit Waren der Informationstechnologie zu erreichen;

*in dem Wunsch*, die technische Entwicklung der Informationsindustrie weltweit zu fördern;

*eingedenk* des positiven Beitrags der Informationstechnologie zum weltweiten Wirtschaftswachstum und Wohlergehen;

*einig in dem Entschluß*, die Ergebnisse dieser Verhandlungen umzusetzen, die zusätzliche Zugeständnisse zu denjenigen in den Listen umfassen, die dem Protokoll von Marrakesch zum Allgemeinen Zoll- und Handelsabkommen 1994 als Anlage beigefügt sind;

*in der Erkenntnis*, daß die Ergebnisse dieser Verhandlungen auch gewisse Zugeständnisse umfassen, die in den Verhandlungen gemacht wurden, die zu der Aufstellung der Listen geführt haben, die dem Protokoll von Marrakesch beigefügt sind -

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<sup>1</sup> Für die Zollunion Schweiz und Liechtenstein.



erklären:

1. Die Handelsregelungen einer jeden Vertragspartei sollten sich so entwickeln, daß der Marktzugang für Waren der Informationstechnologie verbessert wird.

2. Gemäß den im Anhang dieser Erklärung ausgeführten Modalitäten bindet und beseitigt jede Vertragspartei die Zölle und die anderen Abgaben und Belastungen jeder Art im Sinne des Artikels II Absatz 1 Buchstabe b) des Allgemeinen Zoll- und Handelsabkommens 1994 für folgende Waren:

- (a) alle Waren, die gemäß dem Harmonisierten System (1996) ("HS") in die Positionen eingereiht oder einzureihen sind, die in der Anlage A zum Anhang dieser Erklärung aufgeführt sind;
- (b) alle in der Anlage B zum Anhang dieser Erklärung aufgeführten Waren, unabhängig davon, ob sie in der Anlage A aufgeführt sind oder nicht;

dies erfolgt durch Senkung der Zollsätze in gleichen Raten in den Jahren 1997 bis 2000; wobei es unter bestimmten Umständen erforderlich sein kann, die Abfolge der Senkungen zeitlich zu strecken und, vor der Umsetzung, den Geltungsbereich zu erweitern.

3. Die Minister geben ihrer Genugtuung über den umfassenden Geltungsbereich der Anlagen zum Anhang dieser Erklärung Ausdruck. Sie weisen ihre jeweiligen Beamten an, sich nach Kräften dafür einzusetzen, daß die plurilateralen technischen Gespräche in Genf auf der Grundlage dieser Modalitäten bis zum 31. Januar 1997 abgeschlossen werden, damit möglichst viele Teilnehmer diese Erklärung umsetzen.

4. Die Minister ersuchen die Minister der anderen WTO-Mitglieder und die Staaten oder gesonderten Zollgebiete auf dem Weg des Beitritts zur WTO, ihren jeweiligen Beamten ähnliche Anweisungen zu geben, so daß sie an den in Absatz 3 genannten technischen Gesprächen teilnehmen und an der Ausweitung des weltweiten Handels mit Waren der Informationstechnologie in vollem Umfang teilhaben können.

Anhang: Modalitäten und Geltungsbereich

Anlage A: Liste der HS-Positionen

Anlage B: Warenliste

## ANHANG

### Modalitäten und Geltungsbereich

Jedes Mitglied der Welthandelsorganisation und jeder Staat oder jedes gesonderte Zollgebiet auf dem Weg des Beitritts zur WTO kann gemäß den folgenden Modalitäten an der Ausweitung des weltweiten Handels mit Waren der Informationstechnologie teilnehmen:

1. Jeder Teilnehmer nimmt die in Absatz 2 der Erklärung beschriebenen Maßnahmen in seine Liste der Zugeständnisse zum Allgemeinen Zoll- und Handelsabkommen 1994 auf und zusätzlich entweder in seinen eigenen amtlichen Zolltarif oder in irgendeine andere veröffentlichte Fassung des Zolltarifs, je nachdem, welcher normalerweise von den Einführern und den Ausführern verwendet wird, entweder unter den entsprechenden Positionen des eigenen Zolltarifs oder unter den sechsstelligen Codes des Harmonisierten Systems (1996) ("HS"). Die Teilnehmer, die nicht WTO-Mitglieder sind, setzen diese Maßnahmen, solange ihr WTO-Beitritt aussteht, autonom um und nehmen sie in ihre WTO-Zugeständnisliste für den Marktzugang auf.

2. Zu diesem Zweck übermittelt jeder Teilnehmer allen anderen Teilnehmern so bald wie möglich und in jedem Fall bis zum 1. März 1997 Unterlagen mit (a) Erläuterungen zur genauen Anwendung der entsprechenden Zölle im Rahmen seiner WTO-Zugeständnisliste und (b) einer Liste mit den genauen HS-Positionen der in der Anlage B aufgeführten Waren. Diese Unterlagen werden bis spätestens 1. April 1997 geprüft und durch Konsens genehmigt. Sobald diese Prüfung abgeschlossen ist, werden die betreffenden Unterlagen als Änderung der Liste des betreffenden Teilnehmers gemäß dem Beschluß über die Verfahren zur Änderung und Berichtigung der Listen der Zugeständnisse vom 26. März 1980 (BISD 27S/25) eingereicht.

(a) Durch die von jedem Teilnehmer zur Änderung seiner Liste vorzuschlagenden Zugeständnisse sind alle Zölle und andere Abgaben und Belastungen jeder Art auf Waren der Informationstechnologie wie folgt zu binden und zu beseitigen:

(i) Sofern von den Teilnehmern kein anderes Verfahren vereinbart wird, werden diese Zölle durch Senkung der Zollsätze in gleichen Raten stufenweise beseitigt. Sofern von den Teilnehmern nicht anders vereinbart, bindet jeder Teilnehmer alle Zölle auf die in den Anhängen aufgeführten Artikel spätestens zum 1. Juli 1997 und nimmt die erste Senkung spätestens am 1. Juli 1997, die zweite Senkung spätestens am 1. Januar 1998 und die dritte Senkung spätestens am 1. Januar 1999 vor, so daß die Zölle spätestens am 1. Januar 2000 vollständig beseitigt sind. Die Teilnehmer kommen überein, unabhängig davon eine Beseitigung der Zölle schon vor diesen Zeitpunkten zu fördern. Der gesenkte Zollsatz ist bei jeder Rate auf die erste Dezimalstelle abzurunden;

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- (ii) die Beseitigung dieser Zölle und Abgaben jeder Art im Sinne des Artikels II Absatz 1 Buchstabe b) des Allgemeinen Abkommens soll bis spätestens 1. Juli 1997 abgeschlossen sein, außer in Ausnahmefällen, die von dem betreffenden Teilnehmer in den Unterlagen darzulegen sind, die den anderen Teilnehmern zur Prüfung vorgelegt werden.
- (b) Mit den Änderungen, die ein Teilnehmer zur Bindung und Beseitigung seiner Zollsätze auf Waren der Informationstechnologie vorschlägt, soll folgendes Ergebnis erzielt werden:
- (i) Im Falle der in der Anlage A genannten HS-Positionen werden, soweit angebracht, Unterpositionen in seiner Liste entsprechend den Unterpositionen des nationalen Zolltarifs geschaffen;
  - (ii) im Falle der in der Anlage B aufgeführten Waren wird seiner Liste ein Anhang beigefügt, der für alle Waren der Anlage B die genauen HS-Positionen entweder in Form der entsprechenden Zolllinie des nationalen Zolltarifs oder des entsprechenden sechsstelligen HS-Codes angibt.

Sobald die vorgeschlagenen Änderungen in Kraft getreten sind, ändert jeder Teilnehmer unverzüglich seine nationale Zugeständnisliste.

3. Die Teilnehmer kommen unter der Schirmherrschaft des Rates für Warenverkehr regelmäßig zusammen, um den Geltungsbereich der Anhänge zu überprüfen und durch Konsens zu beschließen, ob die Anhänge aufgrund der technischen Entwicklung, der Erfahrungen bei der Anwendung der Zollzugeständnisse oder der Änderungen der HS-Nomenklatur geändert und durch neue Waren ergänzt werden sollten, und um über die nichttarifären Handelshemmnisse bei Waren der Informationstechnologie Konsultationen zu führen. Diese Konsultationen berühren nicht die Rechte und Pflichten im Rahmen des WTO-Übereinkommens.

4. Die Teilnehmer kommen so bald wie möglich und in jedem Fall spätestens am 1. April 1997 zusammen, um die eingegangenen Annahmeerklärungen zu überprüfen und die daraus zu ziehenden Schlüsse zu beurteilen. Die Teilnehmer setzen die in der Erklärung vorgesehenen Aktionen um, sofern bis dahin so viele Länder ihre Annahme notifiziert haben, daß ungefähr 90 % des Welthandels<sup>2</sup> mit Waren der Informationstechnologie erfaßt werden und sofern die Abfolge der Senkungen zur Zufriedenheit der Teilnehmer vereinbart wurde. Bei der Prüfung der Frage, ob die in der Erklärung vorgesehenen Aktionen auch dann umzusetzen sind, wenn der Anteil der Teilnehmer am Welthandel mit Waren der Informationstechnologie leicht unter 90 % liegt, können die Teilnehmer auch berücksichtigen, in welchem Maße Staaten oder gesonderte Zollgebieten teilnehmen, mit denen sie den wesentlichen Anteil ihres Handels mit diesen Waren abwickeln. Auf dieser Tagung legen die Teilnehmer fest, ob diese Kriterien erfüllt sind.

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<sup>2</sup> Dieser Prozentsatz wird vom WTO-Sekretariat auf der Grundlage der zum Zeitpunkt des Treffens neuesten Daten ermittelt.

[REDACTED]

5. Die Teilnehmer kommen so oft wie notwendig und spätestens am 30. September 1997 zusammen, um alle Meinungsverschiedenheiten bei der Einreihung der Waren der Informationstechnologie, angefangen von den in der Anlage B aufgeführten Waren, zu prüfen. Die Teilnehmer kommen überein, daß es ihr gemeinsames Ziel ist, soweit angebracht, unter Berücksichtigung der Auslegungen und Entscheidungen des Rates für die Zusammenarbeit auf dem Gebiet des Zollwesens (auch bekannt als WCO - Weltzollorganisation) eine gemeinsame Einreihung dieser Waren in der bestehenden HS-Nomenklatur zu erreichen. Sollten Meinungsverschiedenheiten über die Einreihung fortbestehen, prüfen die Teilnehmer, ob der WCO ein gemeinsamer Vorschlag zur Überarbeitung der HS-Nomenklatur oder zur Lösung des Problems durch eine entsprechende Auslegung der HS-Nomenklatur vorzulegen ist.

6. Die Teilnehmer gehen davon aus, daß Artikel XXIII des Allgemeinen Abkommens für den Fall anwendbar ist, daß Vorteile, die sich mittelbar oder unmittelbar aus der Umsetzung dieser Erklärung für ein teilnehmendes WTO-Mitglied ergeben, aufgrund der Anwendung einer Maßnahme durch ein anderes teilnehmendes WTO-Mitglied zunichte gemacht oder geschmälert werden, unabhängig davon, ob diese Maßnahme mit den Bestimmungen des Allgemeinen Abkommens kollidiert oder nicht.

7. Jeder Teilnehmer prüft Anträge anderer Teilnehmer auf Konsultationen über die oben ausgeführten Verpflichtungen wohlwollend. Diese Konsultationen berühren nicht die Rechte und Pflichten im Rahmen des WTO-Übereinkommens.

8. Die Teilnehmer, die unter der Schirmherrschaft des Rates für Warenverkehr handeln, unterrichten die anderen WTO-Mitglieder sowie die Staaten oder gesonderten Zollgebiete auf dem Weg des Beitritts zur WTO über diese Modalitäten und leiten Konsultationen ein, um deren Teilnahme an der Ausweitung des Handels mit Waren der Informationstechnologie auf der Grundlage dieser Erklärung zu erleichtern.

9. Im Sinne der vorliegenden Modalitäten bezeichnet der Ausdruck "Teilnehmer" jene WTO-Mitglieder und Staaten oder gesonderte Zollgebiete auf dem Weg des Beitritts zur WTO, die die in Absatz 2 genannten Unterlagen bis spätestens 1. März 1997 einreichen.

10. Dieser Anhang steht allen WTO-Mitgliedern und jedem Staat oder gesonderten Zollgebiet auf dem Weg des Beitritts zur WTO zur Annahme offen. Die Annahme ist dem Generaldirektor schriftlich zu notifizieren, der seinerseits alle Teilnehmer hiervon unterrichtet.

There are two attachments to the Annex.

Attachment A lists the HS headings or parts thereof to be covered.

Attachment B lists specific products to be covered by an ITA wherever they are classified in the HS .

Attachment A, Section 1

	HS96		HS description
	3818		Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics
	8469	11	Word processing machines
	8470		Calculating machines and pocket-size data recording, reproducing and displaying machines with a calculating function; accounting machines, postage franking machines, ticket-issuing machines and similar machines, incorporating a calculating devices; cash registers:
	8470	10	Electronic calculators capable of operating without an external source of electric power and pocket size data recording, reproducing and displaying machines with calculating functions
	8470	21	Other electronic calculating machines incorporating a printing device
	8470	29	Other
	8470	30	Other calculating machines
	8470	40	Accounting machines
	8470	50	Cash registers
	8470	90	Other
	8471		Automatic data processing machines and units thereof; magnetic or optical readers, machines for transcribing data onto data media in coded form and machines for processing such data, not elsewhere specified or included:
	8471	10	Analogue or hybrid automatic data processing machines
	8471	30	Portable digital automatic data processing machines, weighing no more than 10 kg, consisting of at least a central processing unit, a keyboard and a display
	8471	41	Other digital automatic data processing machines comprising in the same housing at least a central processing unit and an input and output unit, whether or not combined
	8471	49	Other digital automatic data processing machines presented in the form of systems
	8471	50	Digital processing units other than those of subheading 8471 41 and 8471 49, whether or not in the same housing one or two of the following types of units : storage units, input units, output units
	8471	60	Input or output units, whether or not containing storage units in the same housing
	8471	70	Storage units, including central storage units, optical disk storage units, hard disk drives and magnetic tape storage units
	8471	80	Other units of automatic data processing machines
	8471	90	Other
ex	8472	90	Automatic teller machines
	8473	21	Parts and accessories of the machines of heading No 8470 of the electronic calculating machines of subheading 8470 10, 8470 21 and 8470 29
	8473	29	Parts and accessories of the machines of heading No 8470 other than the electronic calculating machines of subheading 8470 10, 8470 21 and 8470 29
	8473	30	Parts and accessories of the machines of heading No 8471

	8473	50	Parts and accessories equally suitable for use with machines of two or more of the headings Nos. 8469 to 8472
ex	8504	40	Static converters for automatic data processing machines and units thereof, and telecommunication apparatus
ex	8504	50	Other inductors for power supplies for automatic data processing machines and units thereof, and telecommunication apparatus
	8517		Electrical apparatus for line telephony or line telegraphy, including line telephone sets with cordless handsets and telecommunication apparatus for carrier-current line systems or for digital line systems; videophones:
	8517	11	Line telephone sets with cordless handsets
	8517	19	Other telephone sets and videophones
	8517	21	Facsimile machines
	8517	22	Teleprinters
	8517	30	Telephonic or telegraphic switching apparatus
	8517	50	Other apparatus, for carrier-current line systems or for digital line systems
	8517	80	Other apparatus including entry-phone systems
	8517	90	Parts of apparatus of heading 8517
ex	8518	10	Microphones having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 10 mm and a height not exceeding 3 mm, for telecommunication use
ex	8518	30	Line telephone handsets
ex	8518	29	Loudspeakers, without housing, having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 50 mm, for telecommunication use
	8520	20	Telephone answering machines
	8523	11	Magnetic tapes of a width not exceeding 4 mm
	8523	12	Magnetic tapes of a width exceeding 4 mm but not exceeding 6,5 mm
	8523	13	Magnetic tapes of a width exceeding 6,5 mm
	8523	20	Magnetic discs
	8523	90	Other
	8524	31	Discs for laser reading systems for reproducing phenomena other than sound or image
ex	8524	39	Other : - for reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine
	8524	40	Magnetic tapes for reproducing phenomena other than sound or image
	8524	91	Media for reproducing phenomena other than sound or image
ex	8424	99	Other : - for reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine
ex	8525	10	Transmission apparatus other than apparatus for radio-broadcasting or television
	8525	20	Transmission apparatus incorporating reception apparatus
ex	8525	40	Digital still image video cameras
ex	8527	90	Portable receivers for calling, alerting or paging
ex	8529	10	Aerials or antennae of a kind used with apparatus for radio-telephony and radio-telegraphy

ex	8529	90	Parts of: transmission apparatus other than apparatus for radio-broadcasting or television transmission apparatus incorporating reception apparatus digital still image video cameras, portable receivers for calling, alerting or paging
	8531	20	Indicator panels incorporating liquid crystal devices (LCD) or light emitting diodes (LED)
ex	8531	90	Parts of apparatus of subheading 8531 20
	8532		Electrical capacitors, fixed, variable or adjustable (pre-set):
	8532	10	Fixed capacitors designed for use in 50/60 Hz circuits and having a reactive power handling capacity of not less than 0,5 kvar (power capacitors)
	8532	21	Tantalum fixed capacitors
	8532	22	Aluminium electrolytic fixed capacitors
	8532	23	Ceramic dielectric, single layer fixed capacitors
	8532	24	Ceramic dielectric, multilayer fixed capacitors
	8532	25	Dielectric fixed capacitors of paper or plastics
	8532	29	Other fixed capacitors
	8532	30	Variable or adjustable (pre-set) capacitors
	8532	90	Parts
	8533		Electrical resistors (including rheostats and potentiometers), other than heating resistors:
	8533	10	Fixed carbon resistors, composition or film types
	8533	21	Other fixed resistors for a power handling capacity not exceeding 20 W
	8533	29	Other fixed resistors for a power handling capacity of 20 W or more
	8533	31	Wirewound variable resistors, including rheostats and potentiometers, for a power handling capacity not exceeding 20 W
	8533	39	Wirewound variable resistors, including rheostats and potentiometers, for a power handling capacity of 20 W or more
	8533	40	Other variable resistors, including rheostats and potentiometers
	8533	90	Parts
	8534		Printed circuits
ex	8536	50	Electronic AC switches consisting of optically coupled input and output circuits (insulated thyristor AC switches)
ex	8536	50	Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology) for a voltage not exceeding 1000 volts
ex	8536	50	Electromechanical snap-action switches for a current not exceeding 11 amps
ex	8536	69	Plugs and sockets for co-axial cables and printed circuits
ex	8536	90	Connection and contact elements for wires and cables
	8541		Diodes, transistors and similar semiconductor devices; photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light-emitting diodes; mounted piezo-electric crystals:
	8541	10	Diodes, other than photosensitive or light-emitting diodes
	8541	21	Transistors, other than photosensitive transistors, with a dissipation rate of less than 1 W
	8541	29	Transistors, other than photosensitive transistors, with a dissipation rate of 1 W or more

	8541	30	Thyristors, diacs and triacs, other than photosensitive devices
	8541	40	Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes
	8541	50	Other semiconductor devices
	8541	60	Mounted piezo-electric crystals
	8541	90	Parts
	8542		Electronic integrated circuits and microassemblies
	8542	12	Cards incorporating an electronic integrated circuit ('smart' cards)
	8542	13	Metal oxide semiconductors (MOS technology)
	8542	14	Circuits obtained by bipolar technology
	8542	19	Other monolithic digital integrated circuits, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)
	8542	30	Other monolithic integrated circuits
	8542	40	Hybrid integrated circuits
	8542	50	Electronic microassemblies
	8542	90	Part
	8543	81	Proximity cards and tags
ex	8543	89	Electrical machines with translation or dictionary functions
ex	8544	41	Other electric conductors, for a voltage not exceeding 80 V, fitted with connectors, of a kind used for telecommunications
ex	8544	49	Other electric conductors, for a voltage not exceeding 80 V, not fitted with connectors, of a kind used for telecommunications
ex	8544	51	Other electric conductors, for a voltage exceeding 80 V but not exceeding 1000 V, fitted with connectors, of a kind used for telecommunications
	8544	70	Optical fibre cables
	9009	11	Electrostatic photocopying apparatus, operating by reproducing the original image directly onto the copy (direct process)]
	9009	21	Other photocopying apparatus, incorporating an optical system
	9009	90	Parts and accessories
	9026		Instruments and apparatus for measuring or checking the flow, level, pressure or other variables of liquids or gases (for example, flow meters, level gauges, manometers, heat meters), excluding instruments and apparatus of heading No 9014, 9015, 9028 or 9032:
	9026	10	Instruments for measuring or checking the flow or level of liquids
	9026	20	Instruments and apparatus for measuring or checking pressure
	9026	80	Other instruments and apparatus for measuring or checking of heading 9026
	9026	90	Parts and accessories of instruments and apparatus of heading 9026
	9027	20	Chromatographs and electrophoresis instruments
	9027	30	Spectrometers, spectrophotometers and spectrographs using optical radiations (UV, visible, IR)
	9027	50	Other instruments and apparatus using optical radiations (UV, visible, IR) of heading No 9027
	9027	80	Other instruments and apparatus of heading No 9027 (other than those of heading No 9027 10)
ex	9027	90	Parts and accessories of products of heading 9027, other than for gas or smoke analysis apparatus and microtomes



	9030	40	Instruments and apparatus for measuring and checking, specially designed for telecommunications (for example, cross-talk meters, gain measuring instruments, distortion factor meters, psophometers)
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Attachment A, Section 2

Semiconductor manufacturing and testing equipment and parts thereof

	HS Code	Description	Comments
ex	7017 10	Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	For Attachment B
ex	8419 89	Chemical vapor deposition apparatus for semiconductor production	For Attachment B
ex	8419 90	Parts of chemical vapor deposition apparatus for semiconductor production	For Attachment B
ex	8421 19	Spin dryers for semiconductor wafer processing	
ex	8421 91	Parts of spin dryers for semiconductor wafer processing	
ex	8424 89	Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process	
ex	8424 89	Spraying appliances for etching, stripping or cleaning semiconductor wafers	
ex	8424 90	Parts of spraying appliances for etching, stripping or cleaning semiconductor wafers	
ex	8456 10	Machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	
ex	8456 91	Apparatus for stripping or cleaning semiconductor wafers	For Attachment B
	8456 91	Machines for dry-etching patterns on semiconductor materials	
ex	8456 99	Focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	
ex	8456 99	Lasercutters for cutting contacting tracks in semiconductor production by laser beam	For Attachment B
ex	8464 10	Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	For Attachment B
ex	8464 20	Grinding, polishing and lapping machines for processing of semiconductor wafers	
ex	8464 90	Dicing machines for scribing or scoring semiconductor wafers	
ex	8466 91	Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	For Attachment B
ex	8466 91	Parts of dicing machines for scribing or scoring semiconductor wafers	For Attachment B
ex	8466 91	Parts of grinding, polishing and lapping machines for processing of semiconductor wafers	
ex	8466 93	Parts of focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	
ex	8466 93	Parts of lasercutters for cutting contacting tracks in semiconductor production by laser beam	For Attachment B
ex	8466 93	Parts of machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	
ex	8456 93	Parts of apparatus for stripping or cleaning semiconductor wafers	For Attachment B
ex	8466 93	Parts of machines for dry-etching patterns on semiconductor materials	
ex	8477 10	Encapsulation equipment for assembly of semiconductors	For Attachment B
ex	8477 90	Parts of encapsulation equipment	For Attachment B

ex	8479 50	Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	For Attachment B
ex	8479 89	Apparatus for growing or pulling monocrystal semiconductor boules	
ex	8479 89	Apparatus for physical deposition by sputtering on semiconductor wafers	For Attachment B
ex	8479 89	Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	For Attachment B
ex	8479 89	Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	For Attachment B
ex	8479 89	Encapsulation equipment for assembly of semiconductors	For Attachment B
ex	8479 89	Epitaxial deposition machines for semiconductor wafers	
ex	8479 89	Machines for bending, folding and straightening semiconductor leads	For Attachment B
ex	8479 89	Physical deposition apparatus for for semiconductor production	For Attachment B
ex	8479 89	Spinners for coating photographic emulsions on semiconductor wafers	For Attachment
ex	8479 90	Part of apparatus for physical deposition by sputtering on semiconductor wafers	For Attachment B
ex	8479 90	Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	For Attachment B
ex	8479 90	Parts for spinners for coating photographic emulsions on semiconductor wafers	For Attachment B
ex	8479 90	Parts of apparatus for growing or pulling monocrystal semiconductor boules	
ex	8479 90	Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	For Attachment B
ex	8479 90	Parts of automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	For Attachment B
ex	8479 90	Parts of encapsulation equipment for assembly of semiconductors	For Attachment B
ex	8479 90	Parts of epitaxial deposition machines for semiconductor wafers	
ex	8479 90	Parts of machines for bending, folding and straightening semiconductor leads	For Attachment B
ex	8479 90	Parts of physical deposition apparatus for for semiconductor production	For Attachment B
ex	8480 71	Injection and compression moulds for the manufacture of semiconductor devices	
ex	8514 10	Resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	
ex	8514 20	Inductance or dielectric furnaces and ovens for the manufacture of semiconductor devices on semiconductors wafers	
ex	8514 30	Apparatus for rapid heating of semiconductor wafers	For Attachment B
ex	8514 30	Parts of resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	
ex	8514 90	Parts of apparatus for rapid heating of wafers	For Attachment B
ex	8514 90	Parts of furnaces and ovens of Headings No 8514 10 to No 8514 30	
ex	8536 90	Wafer probers	For Attachment B
	8543 11	Ion implanters for doping semiconductor materials	
ex	8543 30	Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	For Attachment B

ex	8543 90	Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	For Attachment B
ex	8543 90	Parts of ion implanters for doping semiconductor materials	
	9010 41 to 9010 49	Apparatus for projection, drawing or plating circuit patterns on sensitized semiconductor materials and flat panel displays	
ex	9010 90	Parts and accessories of the apparatus of Headings No 9010 41 to 9010 49	
ex	9011 10	Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	For Attachment B
ex	9011 20	Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	For Attachment B
ex	9011 90	Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	For Attachment B
ex	9011 90	Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	For Attachment B
ex	9012 10	Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	For Attachment B
ex	9012 90	Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	For Attachment B
ex	9017 20	Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	For Attachment B
ex	9017 90	Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	For Attachment B
ex	9017 90	Parts of such pattern generating apparatus	For Attachment B
	9030 82	Instruments and apparatus for measuring or checking semiconductor wafers or devices	
ex	9030 90	Parts and accessories of instruments and apparatus for measuring or checking semiconductor wafers or devices	
ex	9030 90	Parts of instruments and appliances for measuring or checking semiconductor wafers or devices	
	9031 41	Optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices	
ex	9031 49	Optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	
ex	9031 90	Parts and accessories of optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices	
ex	9031 90	Parts and accessories of optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	

Attachment B

Positive list of specific products to be covered by this agreement wherever they are classified in the HS.

Where parts are specified, they are to be covered in accordance with HS Notes 2(b) to Section XVI and Chapter 90, respectively.

<p><b>Computers:</b> automatic data processing machines capable of 1) storing the processing program or programs and at least the data immediately necessary for the execution of the program; 2) being freely programmed in accordance with the requirements of the user; 3) performing arithmetical computations specified by the user; and 4) executing, without human intervention, a processing program which requires them to modify their execution, by logical decision during the processing run.</p> <p>The agreement covers such automatic data processing machines whether or not they are able to receive and process with the assistance of central processing unit telephony signals, television signals, or other analogue or digitally processed audio or video signals. Machines performing a specific function other than data processing, or incorporating or working in conjunction with an automatic data processing machine, and not otherwise specified under Attachment A or B, are not covered by this agreement.</p>
<p><b>Electric amplifiers</b> when used as repeaters in line telephony products falling within this agreement, and parts thereof</p>
<p><b>Flat panel displays</b> (including LCD, Electro Luminescence, Plasma and other technologies) for products falling within this agreement, and parts thereof.</p>
<p><b>Network equipment:</b> Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units - including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof.</p>
<p><b>Monitors :</b> display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement.</p> <p>The agreement does not, therefore, cover televisions, including high definition televisions.<sup>3</sup></p>
<p><b>Optical disc storage units,</b> for automatic data processing machines (including CD drives and DVD-drives), whether or not having the capability of writing/recording as well as reading, whether or not in their own housings.</p>
<p><b>Paging alert devices,</b> and parts thereof .</p>
<p><b>Plotters</b> whether input or output units of HS heading No 8471 or drawing or drafting machines of HS heading No 9017.</p>
<p><b>Printed Circuit Assemblies</b> for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard.</p> <p>Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.</p>
<p><b>Projection type flat panel display units</b> used with automatic data processing machines which can display digital information generated by the central processing unit.</p>

<sup>3</sup> Participants will conduct a review of this product description in January 1999 under the consultation provisions of paragraph 3 of the Declaration

**Proprietary format storage devices** including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units.

**Multimedia upgrade kits** for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).

**Set top boxes which have a communication function:** a microprocessor-based device incorporating a modem for gaining access to the Internet, and having a function of interactive information exchange

## EC - ITA - Schedule CXL

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
3818 00	Chemical elements doped for use in electronics, in the form of discs, wafers or similar forms, chemical compounds doped for use in electronics						
3818 00 10	- Doped silicon	6.9	free	5.2	3.5	1.7	free
3818 00 90	- Other	6.9	free	5.2	3.5	1.7	free
7020 00	Other articles of glass						
7020 00 05	- Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	4	free	3.0	2.0	1.0	free
7020 00 10	- Of fused quartz or other fused silica						
7020 00 30	- Of glass having a linear coefficient of expansion not exceeding $5 \times 10^{-6}$ per Kelvin within a temperature range of 0 °C to 300 °C						
7020 00 80	- Other						
8419	Machinery, plant or laboratory equipment, whether or not electrically heated, for the treatment of materials by a process involving a change of temperature such as heating, cooking, roasting, distilling, rectifying, sterilizing, pasteurizing, steaming, drying, evaporating, vapourizing, condensing or cooling, other than machinery or plant of a kind used for domestic purposes; instantaneous or storage water heaters, non-electric :						
8419 89	-- Other						
8419 89 10	--- Cooling towers and similar plant for direct cooling (without a separating wall) by means of recirculated water						
8419 89 15	--- Apparatus for rapid heating of semiconductor wafers	free	free	free	free	free	free
8419 89 20	--- Apparatus for chemical vapour deposition on semiconductor wafers	free	free	free	free	free	free
8419 89 25	--- Apparatus for physical vapour deposition by electronic beam or evaporation on semiconductor wafers	free	free	free	free	free	free
8419 89 30	--- Vacuum-vapour plant for the deposition of metal						
8419 89 95	--- Other						
8419 90	- Parts						
8419 90 10	-- Of heat exchange units, for use in civil aircraft						
8419 90 20	-- Of subheading 8419 20 00						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8419 90 30	-- For apparatus of subheading 8419 89 15 to 8419 89 25	2.7	free	2.0	1.4	0.7	free
8419 90 80	-- Other						
8421	Centrifuges including centrifugal dryers filtering or purifying machinery and apparatus for liquids or gases						
8421 19	-- Other						
8421 19 10	--- For use in civil aircraft						
	--- Other						
8421 19 91	---- Centrifuges of a kind used in laboratories						
	---- Centrifuges of a kind used in the manufacturing of semiconductors wafers						
8421 19 93	----- Spinners for coating photographic emulsions on semiconductor wafers	free	free	free	free	free	free
8421 19 95	----- Other	1.5	free	1.1	0.8	0.4	free
8421 19 97	---- Other						
	- Parts						
	-- Of centrifuges including centrifugal dryers						
8421 91 10	--- For apparatus of subheading 8421 19 93 and 8421 19 95	2.5	free	1.9	1.3	0.6	free
8421 91 90	--- Other						
8421 99 00	-- Other						
8424	Mechanical appliances (whether or not hand-operated) for projecting dispersing or spraying liquids or powders fire extinguishers whether or not charged spray guns and similar appliances steam or sand blasting machines and similar jet projecting machines :						
8424 89	-- Other						
8424 89 20	--- Spraying appliances for etching stripping or cleaning semiconductor wafers	free	free	free	free	free	free
8424 89 30	--- Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process	2.8	free	2.1	1.4	0.7	free
8424 89 80	--- Other						
8424 90	- Parts						
8424 90 10	-- Of apparatus of heading 8424 89 20	2.8	free	2.1	1.4	0.7	free
8424 90 90	-- Other						
8428	Other lifting handling loading or unloading machinery (for example lifts escalators conveyors teleferics)						



CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8428 39	-- Other						
8428 39 10	--- For use in civil aircraft						
	--- Other						
8428 39 91	---- Roller conveyors						
8428 39 93	---- Automated material handling machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	free	free	free	free	free	free
8428 39 98	---- Other						
8431	Parts suitable for use solely or principally with the machinery of heading Nos 8425 to 8430						
8431 39	-- Other						
8431 39 10	--- Of rolling-mill machinery of subheading 8428 90 30						
8431 39 20	--- Of machinery of heading 8428 39 93	1.6	free	1.2	0.8	free	free
8431 39 80	--- Other						
8456	Machine-tools for working any material by removal of material, by laser or other light or photon beam, ultrasonic, electro-discharge, electro-chemical, electron beam, ionic-beam or plasma arc processes :						
8456 10	- Operated by laser or other light or photon beam processes						
8456 10 10	-- Of a kind used in the manufacturing of semiconductor wafers or devices	4.7	free	3.5	2.4	1.2	free
8456 10 90	-- Other						
8456 91 00	-- For dry-etching patterns on semiconductor materials	free	free	free	free	free	free
8456 99	-- Other						
8456 99 10	--- Focused ion beam milling machines for producing or repairing masks and reticles for patterns on semiconductor devices	free	free	free	free	free	free
8456 99 30	--- Apparatus for stripping or cleaning semiconductor wafers	free	free	free	free	free	free
8456 99 90	--- Other						
8462	Machine-tools (including presses) for working metal by forging, hammering or die-stamping; machine-tools (including presses) for working metal by bending, folding, straightening, flattening, shearing, punching or notching; presses for working metal or metal carbides, not specified above :						
	- Bending, folding, straightening or flattening machines (including presses)						
8462 21	-- Numerically controlled						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8462 21 05	--- of a kind used in manufacturing semiconductor leads	3.2	free	2.4	1.6	0.8	free
8462 21 10	--- For working flat products						
8462 21 80	--- Other						
8462 29	-- Other						
8462 29 05	--- For bending, folding and straightening semiconductor leads	1.7	free	1.3	0.8	0.4	free
8462 29 10	--- For working flat products						
	--- Other						
8462 29 91	--- Hydraulic						
8462 29 99	--- Other						
8464	Machine-tools for working stone, ceramics, concrete, asbestos-cement or like mineral materials or for cold working glass						
8464 10	- Sawing machines						
8464 10 10	-- For sawing monocrystal semiconductor boules into slices, or wafers into chips	free	free	free	free	free	free
8464 10 90	-- Other						
8464 20	- Grinding or polishing machines						
8464 20 05	-- For working semiconductor wafers	free	free	free	free	free	free
	-- For working glass						
8464 20 11	--- Optical glass						
8464 20 19	--- Other						
8464 20 80	-- Other						
8464 90	- Other						
8464 90 10	-- For scribing or scoring semiconductor wafers	free	free	free	free	free	free
8464 90 90	-- Other						
8466	Parts and accessories suitable for use solely or principally with the machines of heading Nos 8456 to 8465, including work or tool holders, self-opening dieheads, dividing heads and other special attachments for machine-tools; tool holders for any type of tool for working in the hand :						
	- Other						
8466 91	-- For machines of heading No 8464						
8466 91 15	--- For machines of subheadings 8464 10 10, 8464 20 05 or 8464 90 10	1.9	free	1.4	0.9	0.5	free
8466 91 20	--- Of cast iron or cast steel						
8466 91 95	--- Other						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8466 93	-- For machines of heading Nos 8456 to 8461						
8466 93 15	--- For machines and apparatus of subheadings 8456 10 10, 8456 91 00, 8456 99 10 or 8456 99 30	1.9	free	1.4	0.9	0.5	free
8466 93 20	--- Of cast iron or cast steel						
8466 93 95	--- Other						
8466 94	-- For machines of heading No 8462 or 8463						
8466 94 10	--- For machines of subheading 8462 21 05 or 8452 29 05	1.9	free	1.4	0.9	0.5	free
8466 94 90	--- Other						
	- Automatic typewriters and word-processing machines						
8469 11 00	-- Word-processing machines	3.2	free	2.4	1.6	0.8	free
8470	- Calculating machines and pocket-size data recording, reproducing and displaying machines with calculating functions; accounting machines, postage-franking machines, ticket-issuing machines and similar machines, incorporating a calculating device; cash registers :						
8470 10	- Electronic calculators capable of operation without an external source of electric power and pocket-size data recording, reproducing and displaying machines with calculating functions						
8470 10 10	-- Electronic calculators capable of operation without an external source of electric power	8.4	free	6.3	4.2	2.1	free
8470 10 90	-- Pocket-size data recording, reproducing and displaying machines with calculating functions	5.0	free	3.8	2.5	1.3	free
	- Other electronic calculating machines						
8470 21 00	-- Incorporating a printing device	8.4	free	6.3	4.2	2.1	free
8470 29 00	-- Other	8.4	free	6.3	4.2	2.1	free
8470 30 00	- Other calculating machines	2.8	free	2.1	1.4	0.7	free
8470 40 00	- Accounting machines	2.8	free	2.1	1.4	0.7	free
8470 50 00	- Cash registers	2.8	free	2.1	1.4	0.7	free
8470 90 00	- Other	2.8	free	2.1	1.4	0.7	free
8471	- Automatic data-processing machines and units thereof; magnetic or optical readers, machines for transcribing data onto data media in coded form and machines for processing such data, not elsewhere specified or included :						
8471 10	- Analogue or hybrid automatic data-processing machines						
8471 10 10	-- For use in civil aircraft	free	free	free	free	free	free
8471 10 90	-- Other	3.5	free	2.6	1.8	0.9	free

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8471 30 00	- Portable digital automatic data-processing machines, weighing not more than 10 kg, consisting of at least a central processing unit, a keyboard and a display	3.5	free	2.6	1.8	0.9	free
	- Other digital automatic data-processing machines						
8471 41	-- Comprising in the same housing at least a central processing unit and an input and output unit, whether or not combined						
8471 41 10	--- For use in civil aircraft	free	free	free	free	free	free
8471 41 90	--- Other	3.5	free	2.6	1.8	0.9	free
8471 49	-- Other, presented in the form of systems						
8471 49 10	--- For use in civil aircraft	free	free	free	free	free	free
8471 49 90	--- Other	3.5	free	2.6	1.8	0.9	free
8471 50	- Digital processing units other than those of subheadings No 8471 41 and 8471 49, whether or not containing in the same housing one or two of the following types of unit: storage units, input units, output units						
8471 50 10	-- For use in civil aircraft	free	free	free	free	free	free
8471 50 90	-- Other	3.5	free	2.6	1.8	0.9	free
8471 60	- Input or output units, whether or not containing storage units in the same housing						
8471 60 10	-- For use in civil aircraft	free	free	free	free	free	free
	-- Other						
8471 60 40	--- Printers	2	free	1.5	1.0	free	free
8471 60 50	--- Keyboards	2	free	1.5	1.0	free	free
8471 60 90	--- Other	2	free	1.5	1.0	free	free
8471 70	- Storage units						
8471 70 10	-- For use in civil aircraft	free	free	free	free	free	free
	-- Other						
8471 70 40	--- Central storage units	2	free	1.5	1.0	free	free
	--- Other						
	---- Disk storage units						
8471 70 51	----- Optical, including magneto-optical	2	free	1.5	1.0	free	free
	----- Other						
8471 70 53	----- Hard disk drives	1.6	free	1.2	0.8	free	free
8471 70 59	----- Other	2	free	1.5	1.0	free	free
8471 70 60	---- Magnetic tape storage units	2	free	1.5	1.0	free	free

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8471 70 90	---- Other	2	free	1.5	1.0	free	free
8471 80	- Other units of automatic data-processing machines						
8471 80 10	-- Peripheral units	2	free	1.5	1.0	free	free
8471 80 90	-- Other	2	free	1.5	1.0	free	free
8471 90 00	- Other	2	free	1.5	1.0	free	free
8472	Other office machines (for example, hectograph or stencil duplicating machines, addressing machines, automatic banknote dispensers, coin-sorting machines, coin-counting or wrapping machines, pencil-sharpening machines, perforating or stapling machines)						
8472 90	- Other						
8472 90 10	-- Coin-sorting, coin-counting or coin-wrapping machines						
8472 90 30	-- Automatic teller machines	3.1	free	2.3	1.6	0.8	free
8472 90 80	-- Other						
8473	Parts and accessories (other than covers, carrying cases and the like) suitable for use solely or principally with machines of heading Nos 8469 to 8472 :						
8473 10	- Parts and accessories of the machines of heading No 8470						
8473 21	-- Of the electronic calculating machines of subheading 8470 10, 8470 21 or 8470 29						
8473 21 10	--- Electronic assemblies	4.3	free	3.2	2.1	1.1	free
8473 21 90	--- Other	2.5	free	1.9	1.3	free	free
8473 29	-- Other						
8473 29 10	--- Electronic assemblies	3.4	free	2.5	1.7	0.8	free
8473 29 90	--- Other	1.6	free	1.2	0.8	free	free
8473 30	- Parts and accessories of the machines of heading No 8471						
8473 30 10	-- Electronic assemblies	3.3	free	2.5	1.6	0.8	free
8473 30 90	-- Other	1.6	free	1.2	0.8	free	free
8473 50	- Parts and accessories equally suitable for use with machines of two or more of the headings Nos 8469 to 8472						
8473 50 10	-- Electronic assemblies	3.4	free	2.5	1.7	0.8	free
8473 50 90	-- Other	1.6	free	1.2	0.8	free	free
8477	Machinery for working rubber or plastics or for the manufacture of products from these materials, not specified or included elsewhere in this chapter :						
8477 10	- Injection-moulding machines						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8477 10 10	-- Encapsulation equipment for assembly of semiconductors	2.8	free	2.1	1.4	0.7	free
8477 10 90	-- Other						
8477 59	-- Other						
8477 59 05	--- Encapsulation equipment for assembly of semiconductors	2.8	free	2.1	1.4	0.7	free
8477 59 10	--- Presses						
8477 59 90	--- Other						
8477 90	- Parts						
8477 90 04	-- For machines of subheadings 8477 10 10 and 8477 59 05	2.8	free	2.1	1.4	0.7	free
8477 90 10	-- Of cast iron or cast steel						
8477 90 80	-- Other						
8479	Machines and mechanical appliances having individual functions, not specified or included elsewhere in this chapter						
8479 89	-- Other						
8479 89 10	--- The following goods, for use in civil aircraft: Hydropneumatic batteries; Mechanical actuators for thrust reversers; Toilet units specially designed; Air humidifiers and dehumidifiers; Servo-mechanisms, non-electric; Non-electric starter motors; Pneumatic starters for turbo-jets, turbo-jets, turbo-propellers and other gas turbines; Windscreen wipers, non-electric; Propeller regulators, non-electric						
	--- Other						
8479 89 30	---- Mobile hydraulic powered mine roof supports						
8479 89 60	---- Central greasing systems						
8479 89 65	---- Apparatus for growing or pulling monocrystal semiconductor boules	free	free	free	free	free	free
8479 89 70	---- Apparatus for epitaxial deposition on semiconductor wafers	free	free	free	free	free	free
8479 89 75	---- Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers	free	free	free	free	free	free
8479 89 76	---- Apparatus for wet etching, developing, stripping or cleaning liquid crystal display substrates	2.8	free	2.1	1.4	0.7	free
8479 89 77	---- Die attach apparatus and tape automated bonders for the assembly of semiconductors	2.8	free	2.1	1.4	0.7	free
8479 89 79	---- Encapsulation equipment for assembly of semiconductors	2.8	free	2.1	1.4	0.7	free
8479 89 95	---- Other						
8479 90	- Parts						
8479 90 10	-- For use in civil aircraft						



CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
	-- Other						
8479 90 50	--- Of machines of subheadings 8479 89 65, 8479 89 70, 8479 89 75, 8479 89 76, 8479 89 77 or 8479 89 79	2.8	free	2.1	1.4	0.7	free
8479 90 92	--- Of cast iron or cast steel						
8479 90 98	--- Other						
8480	Moulding boxes for metal foundry, mould bases, moulding patterns, moulds for metal (other than ingot moulds), metal carbides, glass, mineral materials, rubber or plastics						
	- Moulds for rubber or plastics						
8480 71	-- Injection or compression types						
8480 71 10	--- of a kind used in the manufacturing of semiconductor devices	2.5	free	1.9	1.3	0.6	free
8480 71 90	--- Other						
8504	Electrical transformers, static converters (for example, rectifiers) and inductors :						
8504 40	- Static converters						
8504 40 10	-- For use in civil aircraft						
	-- Other						
	--- Of a kind used with telecommunication apparatus and automatic data-processing machines and units thereof :						
8504 40 30	---- Power supply units of a kind used with automatic data-processing machines	2	free	1.5	1.0	free	free
8504 40 35	---- Other	4.6	free	3.4	2.3	1.1	free
8504 40 50	--- Polycrystalline semiconductors						
	--- Other						
8504 40 93	---- Accumulator chargers						
	---- Other						
8504 40 94	----- Rectifiers						
	----- Inverters						
8504 40 96	----- Having a power handling capacity not exceeding 7.5 kVA						
8504 40 97	----- Having a power handling capacity exceeding 7.5 kVA						
8504 40 99	----- Other						
8504 50	- Other inductors						
8504 50 10	-- For use in civil aircraft						
	-- Other						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8504 50 30	--- Of a kind used for telecommunication apparatus and power supplies for automatic data processing machines and units thereof	4.8	free	3.6	2.4	1.2	free
8504 50 80	--- Other						
8514	Industrial or laboratory electric (including induction or dielectric) furnaces and ovens, other industrial or laboratory induction or dielectric heating equipment						
8514 10	- Resistance heated furnaces and ovens						
8514 10 05	-- For the manufacture of semiconductor devices on semiconductor wafers	3	free	2.3	1.5	0.8	free
	-- Other						
8514 10 10	--- Bakery and biscuit ovens						
8514 10 90	--- Other						
8514 20	- Induction or dielectric furnaces and ovens						
8514 20 05	-- For the manufacture of semiconductor devices on semiconductor wafers	3	free	2.3	1.5	0.8	free
	--- Other						
8514 20 10	-- Induction furnaces and ovens						
8514 20 90	-- Dielectric furnaces and ovens						
8514 30	- Other furnaces and ovens						
	-- Infra-red radiation ovens						
8514 30 11	--- For the manufacture of semiconductor devices on semiconductor wafers	free	free	free	free	free	free
8514 30 19	--- Other						
	-- Other						
8514 30 91	--- For the manufacture of semiconductor devices on semiconductor wafers	free	free	free	free	free	free
8514 30 99	--- Other						
8514 90	- Parts						
8514 90 10	-- Of apparatus of subheading 8514 10 05, 8514 20 05, 8514 30 11 or 8514 30 91	3	free	2.3	1.5	0.8	free
8514 90 90	-- Other						
8515	Electric (including electrically heated gas), laser or other light or photon beam, ultrasonic, electron beam, magnetic pulse or plasma arc soldering, brazing or welding machines and apparatus, whether or not capable of cutting; electric machines and apparatus for hot spraying of metals or cermets						





CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
-	Brazing or soldering machines and apparatus						
8515 11 00	-- Soldering irons and guns						
8515 19 00	-- Other						
-	Machines and apparatus for resistance welding of metal						
8515 21 00	-- Fully or partly automatic						
8515 29	-- Other						
8515 29 10	--- For butt welding						
8515 29 90	--- Other						
-	Machines and apparatus for arc (including plasma arc) welding of metals						
8515 31 00	-- Fully or partly automatic						
8515 39	-- Other						
---	For manual welding with coated electrodes, complete with welding or cutting devices, and consigned with						
8515 39 13	--- Transformers						
8515 39 18	---- Generators or rotary converters or static converters, rectifiers or rectifying apparatus						
8515 39 90	--- Other						
8515 80	- Other machines and apparatus						
8515 80 05	-- Wire bonders of a kind used for manufacturing wafers or devices	3.7	free	2.8	1.9	0.9	free
--	Other						
---	For treating metals						
8515 80 11	---- For welding						
8515 80 19	---- Other						
---	Other						
8515 80 91	---- For resistance welding of plastics						
8515 80 99	---- Other						
8515 90	- Parts						
8515 90 10	-- For machines of subheading 8515 80 05	3.7	free	2.8	1.9	0.9	free
8515 90 90	-- Other						
8517	Electrical apparatus for line telephony or line telegraphy, including line telephone sets with cordless handsets and telecommunication apparatus for carrier-current line systems or for digital line systems; videophones ;						
-	Telephone sets; videophones						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8517 11 00	-- Line telephone sets with cordless handsets	7.5	free	5.6	3.8	1.9	free
8517 19	-- Other						
8517 19 10	--- Videophones	14	free	10.5	7.0	3.5	free
8517 19 90	--- Other	7.5	free	5.6	3.8	1.9	free
	- Facsimile machines and teleprinters						
8517 21 00	-- Facsimile machines	7.5	free	5.6	3.8	1.9	free
8517 22 00	-- Teleprinters	7.5	free	5.6	3.8	1.9	free
8517 30 00	- Telephonic or telegraphic switching apparatus	7.5	free	5.6	3.8	1.9	free
8517 50	- Other apparatus, for carrier-current line systems or for digital line systems						
8517 50 10	-- For carrier-current line systems	4.6	free	3.4	2.3	1.1	free
8517 50 90	-- Other	7.5	free	5.6	3.8	1.9	free
8517 80	- Other apparatus						
8517 80 10	-- Entry-phone systems	7.5	free	5.6	3.8	1.9	free
8517 80 90	-- Other	7.5	free	5.6	3.8	1.9	free
8517 90	- Parts						
	-- Of apparatus for carrier-current line systems of subheading 8517 50 10						
8517 90 11	--- Electronic assemblies	3.6	free	2.7	1.8	0.9	free
8517 90 19	--- Other	3.6	free	2.7	1.8	0.9	free
	-- Other						
8517 90 82	--- Electronic assemblies	4.8	free	3.6	2.4	1.2	free
8517 90 88	--- Other	4.8	free	3.6	2.4	1.2	free
8518	Microphones and stands therefor; loudspeakers, whether or not mounted in their enclosures; headphones, earphones and combined microphone/speaker sets; audio-frequency electric amplifiers; electric sound amplifier sets :						
8518 10	- Microphones and stands therefor						
8518 10 10	-- For use in civil aircraft						
	-- Other						
8518 10 20	--- Microphones having a frequency range of 300 Hz to 3.4 KHz with a diameter not exceeding 3 mm, for telecommunications use	3.5	free	2.6	1.8	0.9	free
8518 10 80	--- Other						
8518 29	-- Other						
8518 29 10	--- For use in civil aircraft						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8518 29 20	--- Loudspeakers having a frequency of 300 Hz to 3.4 KHz with a diameter of not exceeding 10 mm and a height not exceeding 3 mm, for telecommunications use	3.8	free	2.8	1.9	0.9	free
8518 29 80	--- Other						
8518 30	- Headphones, earphones and combined microphone speaker sets						
8518 30 10	-- For use in civil aircraft						
8518 30 20	-- Line telephone handsets	4	free	3.0	2.0	1.0	free
8518 30 80	-- Other						
8520	- Magnetic tape recorders and other sound recording apparatus, whether or not incorporating a sound reproducing device						
8520 20 00	- Telephone answering machines	5.2	free	3.9	2.6	1.3	free
8521	- Video recording or reproducing apparatus, whether or not incorporating a video tuner						
8521 10	- Magnetic tape-type						
8521 10 10	-- For use in civil aircraft						
	-- Other						
8521 10 30	--- Of a width not exceeding 1.3 cm and allowing recording or reproduction at a tape speed not exceeding 50 mm per second						
8521 10 80	--- Other						
8521 90	- Other						
8521 90 10	-- Apparatus as defined in Note 5 E to Chapter 84	14	free	10.5	7.0	3.5	free
8521 90 90	-- Other						
8523	- Prepared unrecorded media for sound recording or similar recording of other phenomena, other than products of Chapter 37 :						
	- Magnetic tapes						
8523 11 00	-- Of a width not exceeding 4 mm	3.2	free	2.4	1.6	0.8	free
8523 12 00	-- Of a width exceeding 4 mm but not exceeding 6.5 mm	4.1	free	3.1	2.0	1.0	free
8523 13 00	-- Of a width exceeding 6.5 mm	4.1	free	3.1	2.0	1.0	free
8523 20	- Magnetic discs						
	-- Rigid						
8523 20 11	--- With a thin film metallic coating, having a coercivity exceeding 600 Oersted and an external diameter not exceeding 231 mm	2	free	1.5	1.0	free	free
8523 20 19	--- Other	4.1	free	3.1	2.0	1.0	free
8523 20 90	-- Other	4.1	free	3.1	2.0	1.0	free
8523 90 00	- Other	4.1	free	3.1	2.0	1.0	free

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8524	Records, tapes and other recorded media for sound or other similarly recorded phenomena, including matrices and masters for the production of records, but excluding products of Chapter 37						
-	Discs for laser reading systems						
8524 31 00	-- For reproducing phenomena other than sound or image	4.1	free	3.1	2.0	1.0	free
8524 32 00	-- For reproducing sound only						
8524 39	-- Other						
8524 39 10	--- for reproducing representations of instructions, data, sound and image recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to the user, by means of an automatic data processing machine	4.1	free	3.1	2.0	1.0	free
8524 39 90	--- Other						
8524 40	- Magnetic tapes for reproducing phenomena other than sound or image						
8524 40 10	-- Bearing data or instructions of a kind used in automatic data-processing machines	2	free	1.5	1.0	free	free
--	Other						
8524 40 91	--- Of a width exceeding 4 mm but not exceeding 6,5 mm	3.6	free	2.7	1.8	0.9	free
8524 40 99	--- Other	4.1	free	3.1	2.0	1.0	free
-	Other						
8524 91	-- For reproducing phenomena other than sound or image						
8524 91 10	--- Bearing data or instructions of a kind used in automatic data-processing machines	2	free	1.5	1.0	free	free
8524 91 90	--- Other	4.1	free	3.1	2.0	1.0	free
8524 99	-- Other						
8524 99 10	--- for reproducing representations of instructions, data, sound and image recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to the user, by means of an automatic data processing machine	4.1	free	3.1	2.0	1.0	free
8524 99 90	--- Other						
8525	Transmission apparatus for radio-telephony, radio-telegraphy, radio-broadcasting or television, whether or not incorporating reception apparatus or sound recording or reproducing apparatus; television cameras; still image video cameras and other video camera recorders						
8525 10	- Transmission apparatus						
--	Radio-telegraphic or radio-telephonic apparatus						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8525 10 10	--- for use in civil aircraft --- Other						
8525 10 50	---- Radio-telegraphic or radio-telephonic apparatus	4.1	free	3.1	2.0	1.0	free
8525 10 80	---- Other						
8525 20	- Transmission apparatus incorporating reception apparatus						
8525 20 10	-- Radio-telegraphic or radio-telephonic apparatus, for use in civil aircraft -- Other	free	free	free	free	free	free
8525 20 91	--- For cellular networks (mobile telephones)	6.5	free	4.9	3.3	1.6	free
8525 20 99	--- Other	6.5	free	4.9	3.3	1.6	free
8525 40	- Still image video cameras and other video camera recorders -- Still image video cameras						
8525 40 11	--- Digital	4.9	free	3.7	2.5	1.2	free
8525 40 19	--- Other -- Other video camera recorders						
8525 40 91	--- Only able to record sound and images taken by the television camera						
8525 40 99	--- Other						
8527	Reception apparatus for radio-telephony, radio-telegraphy or radio-broadcasting, whether or not combined, in the same housing, with sound recording or reproducing apparatus or a clock :						
8527 90	- Other apparatus						
8527 90 10	-- For radio-telephony or radio-telegraphy, for use in civil aircraft -- Other						
8527 90 92	--- Portable receivers for calling, alerting or paging	9.6	free	7.2	4.8	2.4	free
8527 90 98	--- Other						
8528	Reception apparatus for television, whether or not incorporating radio-broadcast receivers or sound or video recording or reproducing apparatus: video monitors and video projectors :						
	- Reception apparatus for television, whether or not incorporating radio-broadcast receivers or sound or video recording or reproducing apparatus						
8528 12	-- Colour						
8528 12 10	--- Apparatus as defined in Note 5 E to Chapter 84 --- Other	14	free	10.5	7.0	3.5	free

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
	---- Television projection equipment						
8528 12 14	----- With scanning parameters not exceeding 625 lines						
	----- With scanning parameters exceeding 625 lines						
8528 12 16	----- With a vertical resolution of less than 700 lines						
8528 12 18	----- With a vertical resolution of 700 lines or more						
	---- Apparatus incorporating a video recorder or reproducer						
8528 12 22	----- With a screen width/height ratio less than 1.5						
8528 12 28	----- Other						
	---- Other						
	----- With integral tube						
	----- With a screen width/height ratio less than 1.5, with a diagonal measurement of the screen						
8528 12 52	----- Not exceeding 42 cm						
8528 12 54	----- Exceeding 42 cm but not exceeding 52 cm						
8528 12 56	----- Exceeding 52 cm but not exceeding 72 cm						
8528 12 58	----- Exceeding 72 cm						
	----- Other						
	----- With scanning parameters not exceeding 625 lines, with a diagonal measurement of the screen						
8528 12 62	----- Not exceeding 75 cm						
8528 12 66	----- Exceeding 75 cm						
	----- With scanning parameters not exceeding 625 lines						
8528 12 72	----- With a vertical resolution of less than 700 lines						
8528 12 76	----- With a vertical resolution of 700 lines or more						
	----- Other						
	----- With screen						
8528 12 81	----- With a screen width/height ratio less than 1.5						
8528 12 89	----- Other						
	----- Without screen						
8528 12 91	----- Video tuners						
8528 12 98	----- Other						
8528 13	-- Black and white or other monochrome						
8528 13 10	--- Apparatus as defined in Note 5 E to Chapter 84	6.8	free	5.1	3.4	1.7	free
8528 13 90	--- Other						
8528 30	- Video projectors						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8528 30 05	-- of a kind used with an automatic data processing machines	14	free	10.5	7.0	3.5	free
	-- Other						
8528 30 20	--- Colour						
8528 30 90	--- Black and white or other monochrome						
8529	Parts suitable for use solely or principally with the apparatus of heading Nos 8525 to 8528						
8529 10	- Aerials and aerial reflectors of all kinds, parts suitable for use therewith						
8529 10 10	-- For use in civil aircraft						
	-- Other						
	--- Aerials						
8529 10 15	---- Aerials of a kind used with apparatus for radio-telephony and radio-telegraphic	5	free	3.8	2.5	1.3	free
8529 10 20	---- Telescopic and whip-type aerials for portable apparatus or for apparatus for fitting in motor vehicles						
	---- Outside aerials for radio or television broadcast receivers						
8529 10 31	----- For reception via satellite						
8529 10 39	----- Other						
8529 10 40	---- Inside aerials for radio or television broadcast receivers, including built-in types						
8529 10 50	---- Other						
8529 10 70	--- Aerial filters and separators						
8529 10 80	--- Other						
8529 90	- Other						
8529 90 10	-- Assemblies and sub-assemblies consisting of two or more parts or pieces fastened or joined together, for apparatus falling within subheadings 8526 10 10, 8526 91 11, 8526 91 19 and 8526 92 10, for use in civil aircraft						
	-- Other						
8529 90 40	--- Parts of apparatus falling within subheadings 8525 10 50, 8525 20 99, 8525 40 31, 8525 90 91 or 8527 90 91	4.7	free	3.5	2.4	1.2	free
	--- Cabinets and cases						
8529 90 51	---- Of wood						
8529 90 59	---- Of other materials						
8529 90 70	--- Electronic assemblies						
	--- Other						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8529 90 81	---- For television cameras of subheading 8525 30 and apparatus of heading Nos 8527 and 8528						
8529 90 89	---- Other						
8531	Electric sound or visual signalling apparatus (for example, bells, sirens, indicator panels, burglar or fire alarms), other than those of heading No 8512 or 8530						
8531 20	- Indicator panels incorporating liquid crystal devices (LCD) or light emitting diodes (LED)						
8531 20 10	-- For use in civil aircraft						
	-- Other						
8531 20 30	--- Incorporating light emitting diodes (LED)	4.2	free	3.2	2.1	1.1	free
	--- Incorporating liquid crystal devices (LCD)						
	---- Incorporating active matrix liquid crystal devices (LCD)						
8531 20 51	----- Colour	4.2	free	3.2	2.1	1.1	free
8531 20 59	----- Black and white or other monochrome	4.2	free	3.2	2.1	1.1	free
8531 20 80	--- Other	4.2	free	3.2	2.1	1.1	free
8531 80	- Other apparatus						
8531 80 10	-- For use in civil aircraft						
	-- Other						
8531 80 30	--- Flat panel devices of a kind used in automatic data processing machines and telecommunications apparatus	3.1	free	2.3	1.6	0.8	free
8531 80 80	--- Other						
8531 90	- Parts						
8531 90 10	-- Of apparatus of subheading 8531 20	4.2	free	3.2	2.1	1.1	free
8531 90 30	-- Of apparatus of subheading 8531 80 30	4.2	free	3.2	2.1	1.1	free
8531 90 80	-- Other						
8532	Electrical capacitors, fixed, variable or adjustable (pre-set) :						
8532 10 00	- Fixed capacitors designed for use in 50/60 Hz circuits and having a reactive power handling capacity of not less than 0.5 kvar (power capacitors)	3.6	free	2.7	1.8	0.9	free
	- Other fixed capacitors						
8532 21 00	-- Tantalum	5	free	3.8	2.5	1.3	free
8532 22 00	-- Aluminium electrolytic	5	free	3.8	2.5	1.3	free
8532 23 00	-- Ceramic dielectric, single layer	3.6	free	2.7	1.8	0.9	free
8532 24 00	-- Ceramic dielectric, multilayer	3.6	free	2.7	1.8	0.9	free



CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8532 25 00	-- Dielectric of paper or plastics	3.6	free	2.7	1.8	0.9	free
8532 29 00	-- Other	3.6	free	2.7	1.8	0.9	free
8532 30 00	- Variable or adjustable (pre-set) capacitors	5	free	3.8	2.5	1.3	free
8532 90 00	- Parts	4.7	free	3.5	2.4	1.2	free
8533	Electrical resistors (including rheostats and potentiometers), other than heating resistors						
8533 10 00	- Fixed carbon resistors, composition or film types	3.7	free	2.8	1.9	0.9	free
	- Other fixed resistors						
8533 21 00	-- For a power handling capacity not exceeding 20 W	3.7	free	2.8	1.9	0.9	free
8533 29 00	-- Other	3.7	free	2.8	1.9	0.9	free
	- Wirewound variable resistors, including rheostats and potentiometers						
8533 31 00	-- For a power handling capacity not exceeding 20 W	3.7	free	2.8	1.9	0.9	free
8533 39 00	-- Other	3.7	free	2.8	1.9	0.9	free
8533 40	- Other variable resistors, including rheostats and potentiometers						
8533 40 10	-- For a power handling capacity not exceeding 20 W	3.7	free	2.8	1.9	0.9	free
8533 40 90	-- Other	3.7	free	2.8	1.9	0.9	free
8533 90 00	- Parts	3.7	free	2.8	1.9	0.9	free
8534 00	Printed circuits						
	- Consisting only of conductor elements and contacts						
8534 00 11	-- Multiple circuits	5.2	free	3.9	2.6	1.3	free
8534 00 19	-- Other	5.2	free	3.9	2.6	1.3	free
8534 00 90	- With other passive elements	5.2	free	3.9	2.6	1.3	free
8536	Electrical apparatus for switching or protecting electrical circuits, or for making connections to or in electrical circuits (for example, switches, relays, fuses, surge suppressors, plugs, sockets, lamp-holders, junction boxes), for a voltage not exceeding 1 000 V :						
8536 50	- Other switches						
8536 50 03	-- Electronic AC switches consisting of optically coupled input and output circuits (Insulated thyristor AC switches)	3.2	free	2.4	1.6	0.8	free
8536 50 05	-- Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology) for a voltage not exceeding 1000 volts	3.2	free	2.4	1.6	0.8	free
8536 50 07	-- Electromechanical snap-action switches for a current not exceeding 11 amps	3.2	free	2.4	1.6	0.8	free
	-- Other						



CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
	--- For a voltage not exceeding 60 V						
8536 50 11	---- Push-button switches						
8536 50 15	---- Rotary switches						
8536 50 19	---- Other						
8536 50 90	--- Other						
8536 69	-- Other						
8536 69 05	--- Plugs and sockets for co-axial cables and printed circuits	3.2	free	2.4	1.6	0.8	free
	--- Other						
8536 69 10	--- For co-axial cables						
8536 69 30	--- For printed circuits						
8536 69 90	--- Other						
8536 90	- Other apparatus						
8536 90 01	-- Prefabricated elements for electrical circuits						
8536 90 10	-- Connections and contact elements for wire and cables	3.2	free	2.4	1.6	0.8	free
8536 90 20	-- Wafer probers	free	free	free	free	free	free
8536 90 85	-- Other						
8541	Diodes, transistors and similar semiconductor devices; photosensitive semi- conductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light-emitting diodes; mounted piezo-electric crystals :						
8541 10	- Diodes, other than photosensitive or light-emitting diodes						
8541 10 10	-- Wafers not yet cut into chips	7	free	3.5	1.8	free	free
	-- Other						
8541 10 91	--- Power rectifier diodes	7	free	3.5	1.8	free	free
8541 10 99	--- Other	7	free	3.5	1.8	free	free
	- Transistors, other than photosensitive transistors						
8541 21	-- With a dissipation rate of less than 1 W						
8541 21 10	--- Wafers not yet cut into chips	7	free	3.5	1.8	free	free
8541 21 90	--- Other	7	free	3.5	1.8	free	free
8541 29	-- Other						
8541 29 10	--- Wafers not yet cut into chips	7	free	3.5	1.8	free	free
8541 29 20	--- PowerMOS field effective transistors	7	free	3.5	1.8	free	free
8541 29 30	--- Insulated gate bipolar transistors (IGBTs)	7	free	3.5	1.8	free	free
8541 29 80	--- Other	7	free	3.5	1.8	free	free
8541 30	- Thyristors, diacs and triacs, other than photosensitive devices						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8541 30 10	-- Wafers not yet cut into chips	7	free	3.5	1.8	free	free
8541 30 90	-- Other	7	free	3.5	1.8	free	free
8541 40	- Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels, light-emitting diodes						
	-- Light-emitting diodes						
8541 40 11	--- Laser diodes	7	free	3.5	1.8	free	free
8541 40 19	--- Other	7	free	3.5	1.8	free	free
	-- Other						
8541 40 91	--- Solar cells whether or not assembled in modules or made up into panels	3.2	free	1.6	0.8	free	free
8541 40 93	--- Photodiodes, phototransistors, photothyristors or photocouples	1.8	free	0.9	0.5	free	free
8541 40 99	--- Other	1.8	free	0.9	0.5	free	free
8541 50	- Other semiconductor devices						
8541 50 10	-- Wafers not yet cut into chips	7	free	3.5	1.8	free	free
8541 50 90	-- Other	7	free	3.5	1.8	free	free
8541 60 00	- Mounted piezo-electric crystals	5.6	free	2.8	1.4	free	free
8541 90 00	- Parts	4.1	free	2.0	1.0	free	free
8542	- Electronic integrated circuits and microassemblies :						
	- Monolithic digital integrated circuits						
8542 12 00	-- Cards incorporating an electronic integrated circuit («smart» cards)	14	free	7.0	3.5	free	free
8542 13	-- Metal oxide semiconductors (MOS technology)						
8542 13 01	--- Wafers not yet cut into chips	7	free	3.5	1.8	free	free
8542 13 05	--- Chips	7	free	3.5	1.8	free	free
	--- Other						
	---- Memories						
	----- Dynamic random-access memories (D-RAMs)						
8542 13 11	----- With a storage capacity not exceeding 4 Mbits	7	free	3.5	1.8	free	free
8542 13 13	----- With a storage capacity exceeding 4 Mbits but not exceeding 16 Mbits	7	free	3.5	1.8	free	free
8542 13 15	----- With a storage capacity exceeding 16 Mbits but not exceeding 64 Mbits	7	free	3.5	1.8	free	free
8542 13 17	----- With a storage capacity exceeding 64 Mbits	7	free	3.5	1.8	free	free

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
	----- Static random-access memories (S-RAMs), including cache random-access memories (cache-RAMs)						
8542 13 22	----- With a storage capacity not exceeding 256 Kbits	free	free	free	free	free	free
8542 13 25	----- With a storage capacity exceeding 256 Kbits but not exceeding 1 Mbit	free	free	free	free	free	free
8542 13 27	----- With a storage capacity exceeding 1 Mbit	free	free	free	free	free	free
	----- UV erasable, programmable, read only memories (EPROMs)						
8542 13 32	----- With a storage capacity not exceeding 1 Mbit	free	free	free	free	free	free
8542 13 35	----- With a storage capacity exceeding 1 Mbit but not exceeding 4 Mbits	free	free	free	free	free	free
8542 13 37	----- With a storage capacity exceeding 4 Mbits	free	free	free	free	free	free
	----- Electrically erasable, programmable, read only memories (EEPROMs), including FLASH EEPROMs						
8542 13 41	----- With a storage capacity not exceeding 1 Mbit	free	free	free	free	free	free
8542 13 43	----- With a storage capacity exceeding 1 Mbit but not exceeding 4 Mbits	free	free	free	free	free	free
8542 13 45	----- With a storage capacity exceeding 4 Mbits but not exceeding 16 Mbits	free	free	free	free	free	free
8542 13 47	----- With a storage capacity exceeding 16 Mbits	free	free	free	free	free	free
8542 13 49	----- Other	free	free	free	free	free	free
8542 13 51	----- Read only memories, non-programmable (ROMs); content addressable memories (CAMs); first-in/first-out read/write memories (FIFOs); last-in first-out read/write memories (LIFOs); ferroelectric memories	free	free	free	free	free	free
8542 13 53	----- Other memories	7	free	3.5	1.8	free	free
8542 13 55	----- Microprocessors	free	free	free	free	free	free
	----- Microcontrollers and microcomputers						
8542 13 61	----- With a processing capacity not exceeding 4 bits	5.6	free	2.8	1.4	free	free
8542 13 63	----- With a processing capacity exceeding 4 bits but not exceeding 8 bits	7	free	3.5	1.8	free	free
8542 13 65	----- With a processing capacity exceeding 8 bits but not exceeding 16 bits	7	free	3.5	1.8	free	free
8542 13 67	----- With a processing capacity exceeding 16 bits but not exceeding 32 bits	7	free	3.5	1.8	free	free
8542 13 69	----- With a processing capacity exceeding 32 bits	7	free	3.5	1.8	free	free

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
	---- Other						
8542 13 70	----- Microperipherals	5.6	free	2.8	1.4	free	free
	----- Other						
8542 13 72	----- Full custom logic circuits	7	free	3.5	1.8	free	free
8542 13 74	----- Gate arrays	7	free	3.5	1.8	free	free
8542 13 76	----- Standard cells	7	free	3.5	1.8	free	free
8542 13 82	----- Programmable logic circuits	5.6	free	2.8	1.4	free	free
8542 13 84	----- Standard logic circuits	5.6	free	2.8	1.4	free	free
	----- Other						
8542 13 91	----- Control circuits, interface circuits, interface circuits capable of performing control functions	7	free	3.5	1.8	free	free
8542 13 99	----- Other	7	free	3.5	1.8	free	free
8542 14	-- Circuits obtained by bipolar technology						
8542 14 01	--- Wafers not yet cut into chips	7	free	3.5	1.8	free	free
8542 14 05	--- Chips	7	free	3.5	1.8	free	free
	--- Other						
	---- Memories						
8542 14 10	----- Dynamic random-access memories (D-RAMs)	7	free	3.5	1.8	free	free
8542 14 15	----- Static random-access memories (S-RAMs), including cache random-access memories (cache-RAMs); read only memories, non-programmable (ROMs); content addressable memories (CAMs); first-in/first-out read/write memories (FIFOs); last-in first-out read/write memories (LIFOs); ferroelectric memories	free	free	free	free	free	free
8542 14 20	----- Electrically erasable, programmable, read only memories (EEPROMs), including FLASH EEPROMs	free	free	free	free	free	free
8542 14 22	----- UV erasable, programmable, read only memories (EPROMs)	free	free	free	free	free	free
8542 14 29	----- Other memories	7	free	3.5	1.8	free	free
8542 14 30	----- Microprocessors	free	free	free	free	free	free
	----- Microcontrollers and microcomputers						
8542 14 42	----- With a processing capacity not exceeding 4 bits	5.6	free	2.8	1.4	free	free
8542 14 44	----- With a processing capacity exceeding 4 bits	7	free	3.5	1.8	free	free
	----- Other						
8542 14 50	----- Microperipherals	5.6	free	2.8	1.4	free	free
	----- Other						
8542 14 60	----- Full custom logic circuits	7	free	3.5	1.8	free	free

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8542 14 65	----- Gate arrays	7	free	3.5	1.8	free	free
8542 14 70	----- Standard cells	7	free	3.5	1.8	free	free
8542 14 75	----- Programmable logic circuits	5.6	free	2.8	1.4	free	free
8542 14 80	----- Standard logic circuits	5.6	free	2.8	1.4	free	free
	----- Other						
8542 14 91	----- Control circuits, interface circuits, interface circuits capable of performing control functions	7	free	3.5	1.8	free	free
8542 14 99	----- Other	7	free	3.5	1.8	free	free
8542 19	-- Other, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)						
8542 19 01	--- Wafers not yet cut into chips	7	free	3.5	1.8	free	free
8542 19 05	--- Chips	7	free	3.5	1.8	free	free
	--- Other						
	---- Memories						
8542 19 15	----- Dynamic random-access memories (D-RAMs)	7	free	3.5	1.8	free	free
	----- Static random-access memories (S-RAMs), including cache random-access memories (cache-RAMs)						
8542 19 22	----- With a storage capacity not exceeding 256 Kbits	free	free	free	free	free	free
8542 19 25	----- With a storage capacity exceeding 256 Kbits but not exceeding 1 Mbit	free	free	free	free	free	free
8542 19 27	----- With a storage capacity exceeding 1 Mbit	free	free	free	free	free	free
8542 19 31	----- UV erasable, programmable, read only memories (EPROMs)	free	free	free	free	free	free
8542 19 35	----- Electrically erasable, programmable, read only memories (E <sup>2</sup> PROMs), including FLASH E <sup>2</sup> PROMs	free	free	free	free	free	free
8542 19 41	----- Read only memories, non-programmable (ROMs); content addressable memories (CAMs); first-in/first-out read/write memories (FIFOs); last-in/first-out read/write memories (LIFOs); ferroelectric memories	free	free	free	free	free	free
8542 19 49	----- Other memories	7	free	3.5	1.8	free	free
8542 19 55	----- Microprocessors	free	free	free	free	free	free
	----- Microcontrollers and microcomputers						
8542 19 62	----- With a processing capacity not exceeding 4 bits	5.6	free	2.8	1.4	free	free
8542 19 68	----- With a processing capacity exceeding 4 bits	7	free	3.5	1.8	free	free
	----- Other						
8542 19 71	----- Microperipherals	5.6	free	2.8	1.4	free	free
	----- Other						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8542 19 72	----- Full custom logic circuits	7	free	3.5	1.8	free	free
8542 19 74	----- Gate arrays	7	free	3.5	1.8	free	free
8542 19 76	----- Standard cells	7	free	3.5	1.8	free	free
8542 19 82	----- Programmable logic circuits	5 6	free	2.8	1.4	free	free
8542 19 84	----- Standard logic circuits	5 6	free	2.8	1.4	free	free
	----- Other						
8542 19 92	----- Control circuits, interface circuits, interface circuits capable of performing control functions	7	free	3.5	1.8	free	free
8542 19 98	----- Other	7	free	3.5	1.8	free	free
8542 30	- Other monolithic integrated circuits						
8542 30 10	-- Wafers not yet cut into chips	7	free	3.5	1.8	free	free
8542 30 20	-- Chips	7	free	3.5	1.8	free	free
	-- Other						
8542 30 30	--- Amplifiers	7	free	3.5	1.8	free	free
8542 30 50	--- Voltage and current regulators	7	free	3.5	1.8	free	free
	--- Control circuits						
8542 30 61	---- Smartpower circuits	7	free	3.5	1.8	free	free
	---- Other						
8542 30 65	----- Mixed analogue-digital circuits	7	free	3.5	1.8	free	free
8542 30 69	----- Other	7	free	3.5	1.8	free	free
8542 30 70	--- Interface circuits, interface circuits capable of performing control functions	7	free	3.5	1.8	free	free
	--- Other						
8542 30 91	---- Smartpower circuits	7	free	3.5	1.8	free	free
	---- Other						
8542 30 95	----- Mixed analogue-digital circuits	7	free	3.5	1.8	free	free
8542 30 99	----- Other						
8542 40	- Hybrid integrated circuits						
8542 40 10	-- Microprocessors, microcontrollers and microcomputers	7	free	3.5	1.8	free	free
8542 40 30	-- Converters	7	free	3.5	1.8	free	free
8542 40 50	-- Amplifiers	7	free	3.5	1.8	free	free
8542 40 90	-- Other	7	free	3.5	1.8	free	free
8542 50 00	- Electronic microassemblies	7	free	3.5	1.8	free	free
8542 90 00	- Parts	4 1	free	2 0	1 0	free	free

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8543	Electrical machines and apparatus, having individual functions, not specified or included elsewhere in this Chapter						
-	Particle accelerators						
8543 11 00	-- Ion implanters for doping semiconductor materials	free	free	free	free	free	free
8543 30	- Machines and apparatus for electroplating, electrolysis or electrophoresis						
8543 30 10	-- Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers	free	free	free	free	free	free
8543 30 20	-- Apparatus for wet etching, developing, stripping or cleaning liquid crystal display substrates	free	free	free	free	free	free
8543 30 90	-- Other						
-	Other machines and apparatus						
8543 81 00	-- Proximity cards and tags	5	free	3.8	2.5	1.3	free
8543 89	-- Other						
8543 89 10	--- Flight recorders, for use in civil aircraft						
8543 89 15	--- Electrical machines with translation or dictionary functions	5	free	3.8	2.5	1.3	free
8543 89 17	--- Apparatus as defined in not 5 E to Chapter 84	5	free	3.8	2.5	1.3	free
8543 89 20	--- Aerial amplifiers						
---	Sunbeds, sunlamps and similar suntanning equipment						
----	For fluorescent tubes using ultraviolet A rays						
8543 89 51	----- With a maximum tube length of 100 cm						
8543 89 55	----- Other						
8543 89 59	----- Other						
---	Apparatus for physical deposition on semiconductors wafers,						
8543 89 70	---- by sputtering on semiconductor wafers	free	free	free	free	free	free
8543 89 72	---- Other	5	free	3.8	2.5	1.3	free
8543 89 73	--- Encapsulation equipment for assembly of semiconductors	5	free	3.8	2.5	1.3	free
8543 89 77	--- Set top boxes, having a communication function, microprocessor based device incorporating a modem for gaining access to the Internet, and having a function of interactive information exchange	5	free	3.8	2.5	1.3	free
8543 89 79	--- Multimedia upgrade kits, for automatic data processing machines and units thereof, put up for retail sale, consisting of, at least, speakers and or microphones, and a printed circuit assembly that enables the automatic data processing and units thereof to process audio signals (sound cards)	5	free	3.8	2.5	1.3	free



CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
8543 89 90	---						
8543 90	-						
8543 90 10	--						
8543 90 20	--	5	free	3.8	2.5	1.3	free
8543 90 30	--	5	free	3.8	2.5	1.3	free
8543 90 90	--						
8544							
8544 41	--						
8544 41 10	---	4.6	free	3.4	2.3	1.1	free
8544 41 90	---						
8544 49	--						
8544 49 20	---	4.8	free	3.6	2.4	1.2	free
8544 49 80	---						
8544 51	--						
8544 51 10	---	4.6	free	3.4	2.3	1.1	free
8544 51 90	---						
8544 70 00	-	6.3	free	4.7	3.1	1.6	free
9006							
9006 10	-						
9006 10 10	--	free	free	free	free	free	free
9006 10 90	--						
9006 91 00	--						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
	-- Other						
9006 99 10	-- of apparatus of subheading 9006 10 10	4	free	3.0	2.0	1.0	free
9006 99 90	-- Other						
9009	Photocopying apparatus incorporating an optical system or of the contact type and thermo-copying apparatus						
	- Electrostatic photocopying apparatus						
9009 11 00	-- Operating by reproducing the original image directly onto the copy (direct process)	6.5	free	4.9	3.3	1.6	free
	- Other photocopying apparatus						
9009 21 00	-- Incorporating an optical system	6.5	free	4.9	3.3	1.6	free
9009 90	- Parts and accessories						
9009 90 10	-- Of electrostatic photocopying apparatus or other photocopying apparatus incorporating an optical system	6.5	free	4.9	3.3	1.6	free
9009 90 90	-- Other	3.8	free	2.8	1.9	0.9	free
9010	Apparatus and equipment for photographic (including cinematographic) laboratories (including apparatus for the projection of circuit patterns on sensitized semi-conductor material), not specified or included elsewhere in this chapter, negatoscopes, projection screens						
	- Apparatus for the projection or drawing of circuit patterns on sensitized semiconductor materials:						
9010 41 00	-- Direct write-on-wafer apparatus	free	free	free	free	free	free
9010 42 00	-- Step and repeat aligners	free	free	free	free	free	free
9010 49 00	-- Other	free	free	free	free	free	free
9010 90	- Parts and accessories						
9010 90 10	-- Of the apparatus of subheadings N° 9010 41 00, 9010 42 00 and 9010 49 00	3.6	free	2.7	1.8	0.9	free
9010 90 90	-- Other						
9011	Compound optical microscopes, including those for photomicrography, cinephotomicrography or microprojection						
	- Stereoscopic microscopes						
9011 10 10	-- fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	8	free	6.0	4.0	2.0	free
9011 10 90	-- Other						
9011 20	- Other microscopes, for photomicrography, cinephotomicrography or micro-projection						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
9011 20 10	-- fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	8	free	6.0	4.0	2.0	free
9011 20 90	-- Other						
9011 90	- Parts and accessories						
9011 90 10	-- Of apparatus of subheadings N° 9011 10 10 or 9011 20 10	8	free	6.0	4.0	2.0	free
9011 90 90	-- Other						
9012	Microscopes other than optical microscopes, diffracto microscopes						
9012 10	- Microscopes other than optical microscopes and diffraction apparatus						
9012 10 10	-- Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	4.5	free	3.4	2.3	1.1	free
9012 10 90	-- Other						
9012 90	- Parts and accessories						
9012 90 10	-- Of apparatus of subheading N° 9012 10 00	4.5	free	3.4	2.3	1.1	free
9012 90 90	-- Other						
9013	Liquid crystal devices not constituting articles provided for more specifically in other headings; lasers, other than laser diodes; other optical appliances and instruments, not specified or included elsewhere in this Chapter						
9013 80	- Other devices, appliances and instruments						
	-- Liquid crystal devices						
	--- Active matrix liquid crystal devices						
9013 80 11	---- Colour	6.5	free	4.9	3.3	1.6	free
9013 80 19	---- Black and white or other monochrome	6.5	free	4.9	3.3	1.6	free
9013 80 30	--- Other	6.5	free	4.9	3.3	1.6	free
9013 80 90	-- Other						
9013 90	- Parts and accessories						
	-- Other						
9013 90 10	--- For liquid crystal devices (LCD)	6.5	free	4.9	3.3	1.6	free
9013 90 90	--- Other						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
9017	Drawing, marking-out or mathematical calculating instruments (for example, drafting machines, pantographs, protractors, drawing sets, slide rules, disc calculators), instruments for measuring length, for use in the hand (for example, measuring rods and tapes, micrometers, callipers), not specified or included else- where in this chapter						
9017 10	- Drafting tables and machines, whether or not automatic						
9017 10 10	-- Plotters	3.7	free	2.8	1.9	0.9	free
9017 10 90	-- Other						
9017 20	- Other drawing, marking-out or mathematical calculating instruments						
	-- Drawing instruments						
9017 20 05	--- Plotters	3.7	free	2.8	1.9	0.9	free
9017 20 11	--- Drawing sets						
9017 20 19	--- Other						
	-- Marking-out instruments						
9017 20 31	--- Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	free	free	free	free	free	free
9017 20 39	--- Other						
9017 20 90	-- Mathematical calculating instruments (including slide rules, disc calculators and the like)						
9017 90	- Parts and accessories						
9017 90 10	-- For apparatus of subheading 9017 20 31	3.7	free	2.8	1.9	0.9	free
9017 90 90	-- Other						
9026	Instruments and apparatus for measuring or checking the flow, level, pressure or other variables of liquids or gases (for example, flow meters, level gauges, mano- meters, heat meters), excluding instruments and apparatus of heading No 9014, 9015, 9028 or 9032 :						
9026 10	- For measuring or checking the flow or level of liquids						
9026 10 10	-- For use in civil aircraft	free	free	free	free	free	free
	-- Other						
	--- Electronic						
9026 10 51	---- Flow meters	4.8	free	3.6	2.4	1.2	free
9026 10 59	---- Other	4.8	free	3.6	2.4	1.2	free
	--- Other						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
9026 10 91	---- Flow meters	3.6	free	2.7	1.8	0.9	free
9026 10 99	---- Other	3.6	free	2.7	1.8	0.9	free
9026 20	- For measuring or checking pressure						
9026 20 10	-- For use in civil aircraft	free	free	free	free	free	free
	-- Other						
9026 20 30	--- Electronic	4.8	free	3.6	2.4	1.2	free
	--- Other						
	---- Spiral or metal diaphragm type pressure gauges						
9026 20 51	----- Appliances for measuring and non-automatically regulating tyre pressure	3.3	free	2.5	1.6	0.8	free
9026 20 59	----- Other	3.3	free	2.5	1.6	0.8	free
9026 20 90	---- Other	3.3	free	2.5	1.6	0.8	free
9026 80	- Other instruments or apparatus						
9026 80 10	-- For use in civil aircraft	free	free	free	free	free	free
	-- Other						
9026 80 91	--- Electronic	4.8	free	3.6	2.4	1.2	free
9026 80 99	--- Other	3.6	free	2.7	1.8	0.9	free
9026 90	- Parts and accessories						
9026 90 10	-- For use in civil aircraft	free	free	free	free	free	free
9026 90 90	-- Other	3.3	free	2.5	1.6	0.8	free
9027	Instruments and apparatus for physical or chemical analysis (for example, polarimeters, refractometers, spectrometers, gas or smoke analysis apparatus); instruments and apparatus for measuring or checking viscosity, porosity, expansion, surface tension or the like; instruments and apparatus for measuring or checking quantities of heat, sound or light (including exposure meters); microtomes :						
9027 20	- Chromatographs and electrophoresis instruments						
9027 20 10	-- Chromatographs	3.5	free	2.6	1.8	0.9	free
9027 20 90	-- Electrophoresis instruments	4.4	free	3.3	2.2	1.1	free
9027 30 00	- Spectrometers, spectrophotometers and spectrographs using optical radiations (UV, visible, IR)	3.5	free	2.6	1.8	0.9	free
9027 50 00	- Other instruments and apparatus using optical radiations (UV, visible, IR)	4.4	free	3.3	2.2	1.1	free
9027 80	- Other instruments and apparatus						
	-- Electronic						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
9027 80 11	--- pH meters, rH meters and other apparatus for measuring conductivity	4.4	free	3.3	2.2	1.1	free
9027 80 15	--- Apparatus for performing measurements of the physical properties of semiconductor materials or associated insulating and conducting layers during the semiconductor wafer production process	free	free	free	free	free	free
9027 80 18	--- Other	4.4	free	3.3	2.2	1.1	free
	-- Other						
9027 80 91	--- Viscometers, porosimeters and expansion meters	4	free	3.0	2.0	1.0	free
9027 80 95	--- Apparatus for performing measurements of the physical properties of semiconductor materials or associated insulating and conducting layers during the semiconductor wafer production process	free	free	free	free	free	free
9027 80 98	--- Other	4	free	3.0	2.0	1.0	free
9027 90	- Microtomes, parts and accessories						
9027 90 10	-- Microtomes						
9027 90 50	-- Part and accessories of apparatus of heading N° 9027 20 to 9027 80	4.4	free	3.3	2.2	1.1	free
9027 90 80	-- Parts and accessories of microtomes or of gas or smoke analysis apparatus						
9030	Oscilloscopes, spectrum analysers and other instruments and apparatus for measuring or checking electrical quantities, excluding meters of heading No 9028; instruments and apparatus for measuring or detecting alpha, beta, gamma, X-ray, cosmic or other ionizing radiations :						
9030 40	- Other instruments and apparatus, specially designed for telecommunications (for example, cross-talk meters, gain measuring instruments, distortion factor meters, psophometers)						
9030 40 10	-- For use in civil aircraft	free	free	free	free	free	free
9030 40 90	-- Other	5.5	free	4.1	2.8	1.4	free
	- Other instruments and apparatus						
9030 82 00	-- For measuring or checking semiconductor wafers or devices	free	free	free	free	free	free
9030 90	- Parts and accessories						
9030 90 10	-- For use in civil aircraft						
9030 90 20	-- For apparatus of subheading N° 9030 82 00	4.4	free	3.3	2.2	1.1	free
9030 90 80	-- Other						

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 1997	Jan. 1998	Jan. 1999	Jan. 2000
9031	Measuring or checking instruments, appliances and machines, not specified or included elsewhere in this chapter - profile projectors - Other optical instruments and appliances						
9031 41 00	-- For inspecting semiconductor wafers or devices or for inspecting photomasks or reticles used in manufacturing semiconductor devices	free	free	free	free	free	free
9031 49	-- Other						
9031 49 10	--- For measuring surface particulate contamination on semiconductor wafers	free	free	free	free	free	free
9031 49 90	--- Other						
9031 90	- Parts and accessories						
9031 90 10	-- Of instruments, appliances and machines of subheading 9031 80, for use in civil aircraft						
9031 90 20	-- For apparatus of subheadings N 9031 41 00 and 9031 49 10	4.6	free	3.4	2.3	1.1	free
9031 90 90	-- Other						

## *EC - ITA - Schedule CXL - Attachment A, Section 2*

<i>Description</i>	<i>HS 97 Headings</i>
* Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	<u>70200005</u>
* Chemical vapor deposition apparatus for semiconductor production	<u>84198920</u>
* Parts of chemical vapor deposition apparatus for semiconductor production	<u>84199030</u>
* Spin dryers for semiconductor wafer processing	<u>84211995</u>
* Parts of spin dryers for semiconductor wafer processing	<u>84219110</u>
* Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process	<u>84248930</u>
* Spraying appliances for etching, stripping or cleaning semiconductor wafers	<u>84248920</u>
* Parts of spraying appliances for etching, stripping or cleaning semiconductor wafers	<u>84249010</u>
* Machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	<u>84561010</u>
* Apparatus for stripping or cleaning semiconductor wafers	<u>84569930</u>
* Machines for dry-etching patterns on semiconductor materials	<u>84569100</u>
* Focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	<u>84569910</u>
* Lasercutters for cutting contacting tracks in semiconductor production by laser beam	<u>84561010</u>
* Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	<u>84641010</u>
* Grinding, polishing and lapping machines for processing of semiconductor wafers	<u>84642005</u>
* Dicing machines for scribing or scoring semiconductor wafers	<u>84649010</u>
* Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	<u>84669115</u>
* Parts of dicing machines for scribing or scoring semiconductor wafers	<u>84669115</u>
* Parts of grinding, polishing and lapping machines for processing of semiconductor wafers	<u>84669115</u>
* Parts of focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	<u>84669315</u>
* Parts of lasercutters for cutting contacting tracks in semiconductor production by laser beam	<u>84669315</u>
* Parts of machines for working any material by removal of material, by laser or other light or photo beam in the production of semiconductor wafers	<u>84669315</u>
* Parts of apparatus for stripping or cleaning semiconductor wafers	<u>84669315</u>
* Parts of machines for dry-etching patterns on semiconductor materials	<u>84669315</u>
* Encapsulation equipment for assembly of semiconductors	<u>84771010, 84775905</u>
* Parts of encapsulation equipment	<u>84779004</u>



<i>Description</i>	<i>HS 97 Headings</i>
* Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	<u>84283993</u>
* Apparatus for growing or pulling monocrystal semiconductor boules	<u>84798965</u>
* Apparatus for physical deposition by sputtering on semiconductor wafers	<u>84198925, 85438970</u>
* Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	<u>84798975, 84798976</u>
* Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	<u>84798977, 85158005, 85159010</u>
* Encapsulation equipment for assembly of semiconductors	<u>84798979, 85438973</u>
* Epitaxial deposition machines for semiconductor wafers	<u>84798970</u>
* Machines for bending, folding and straightening semiconductor leads	<u>84622105, 84622905</u>
* Physical deposition apparatus for semiconductor production	<u>85438972</u>
* Spinners for coating photographic emulsions on semiconductor wafers	<u>84211993</u>
* Part of apparatus for physical deposition by sputtering on semiconductor wafers	<u>85439020</u>
* Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	<u>84799050</u>
* Parts for spinners for coating photographic emulsions on semiconductor wafers	<u>84219110</u>
* Parts of apparatus for growing or pulling monocrystal semiconductor boules	<u>84799050</u>
* Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	<u>84799050, 85439020</u>
* Parts of automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	<u>84313920</u>
* Parts of encapsulation equipment for assembly of semiconductors	<u>84799050, 85439030</u>
* Parts of epitaxial deposition machines for semiconductor wafers	<u>84799050</u>
* Parts of machines for bending, folding and straightening semiconductor leads	<u>84669410</u>
* Parts of physical deposition apparatus for semiconductor production	<u>84199030, 85439030</u>
* Injection and compression moulds for the manufacture of semiconductor devices	<u>84807110</u>
* Resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	<u>85141005, 85143011, 85143091</u>
* Inductance or dielectric furnaces and ovens for the manufacture of semiconductor devices on semiconductors wafers	<u>85142005</u>
* Apparatus for rapid heating of semiconductor wafers	<u>84198915, 85143091</u>
* Parts of resistance heated furnaces and ovens for the manufacture of semiconductor devices on semiconductor wafers	<u>85149010</u>
* Parts of apparatus for rapid heating of wafers	<u>84199030, 85149010</u>
* Parts of furnaces and ovens of Headings No 8514 10 to No 8514 30	<u>85149010</u>
* Wafer probers	<u>85369020</u>
* Ion implanters for doping semiconductor materials	<u>85431100</u>
* Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	<u>84798975, 84798976, 85433010, 85433020</u>

<i>Description</i>	<i>HS 97 Headings</i>
* Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	<u>84799050, 85439020</u>
* Parts of ion implanters for doping semiconductor materials	<u>85439020</u>
* Apparatus for projection, drawing or plating circuit patterns on sensitized semiconductor materials and flat panel displays	<u>90104100, 90104200, 90104900</u>
* Parts and accessories of the apparatus of Headings No 9010 41 to 9010 49	<u>90109010</u>
* Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	<u>90111010</u>
* Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	<u>90112010</u>
* Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	<u>90119010</u>
* Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	<u>90119010</u>
* Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	<u>90121010</u>
* Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	<u>90129010</u>
* Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	<u>90061010, 90172031</u>
* Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	<u>90069910, 90179010</u>
* Parts of such pattern generating apparatus	<u>90179010</u>
* Instruments and apparatus for measuring or checking semiconductor wafers or devices	<u>90308200</u>
* Parts and accessories of instruments and apparatus for measuring or checking semiconductor wafers or devices	<u>90309020</u>
* Parts of instruments and appliances for measuring or checking semiconductor wafers or devices	<u>90309020</u>
* Optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices	<u>90314100</u>
* Optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	<u>90314910</u>
* Parts and accessories of optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices	<u>90319020</u>
* Parts and accessories of optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	<u>90319020</u>

# EC - ITA - Schedule CXL - Attachment B

<i>Description</i>	<i>HS 97 Headings</i>
<p>* Computers: automatic data processing machines capable of</p> <p>1) storing the processing program or programs and at least the data immediately necessary for the execution of the program;</p> <p>2) being freely programmed in accordance with the requirements of the user;</p> <p>3) performing arithmetical computations specified by the user;</p> <p>4) executing without human intervention, a processing program which requires them to modify their execution, by logical decision during the processing run.</p> <p>The agreement covers automatic data processing machines whether or not they are able to receive and process with assistance of central processing unit telephony signals, television signals, or other analogue or digitally processed audio or video signals. Machines performing a specific function other than data processing, or incorporating or working in conjunction with an automatic data processing machine, and not otherwise specified under Attachment A or B, are not covered by this agreement.</p> <p>The agreement covers such automatic data processing machines whether or not they are able to receive and process with the assistance of the central processing unit telephony signals, television signals, or other analogue or digitally processed audio or video signals.</p> <p>However, machines performing a specific function other than data processing, or incorporating or working in conjunction with an automatic data processing machines, and not referred to under part A or B, are excluded from the product coverage of this agreement.</p>	<p><u>84711090, 84713000,</u>  <u>84714190, 84714990,</u>  <u>84715090, 85219010,</u>  <u>85281210, 85281310,</u>  <u>85438917</u></p>
<p>* Electric amplifiers when used as repeaters in line telephony products falling within this agreement, and parts thereof.</p>	<p><u>85175010, 85178090</u></p>
<p>* Flat panel displays (including LCD, Electro Luminescence, Plasma and other technologies) for products falling within this agreement, and parts thereof.</p>	<p><u>85312030, 85312051,</u>  <u>85312059, 85312080,</u>  <u>85318030, 85319010,</u>  <u>85319030, 90138011,</u>  <u>90138019, 90138030,</u>  <u>90139010</u></p>
<p>* Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units - including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof</p>	<p><u>84715090, 84716090,</u>  <u>85175090</u></p>
<p>* Monitors: display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0.4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement. The agreement does not, therefore, cover televisions, including high definition televisions(1)</p> <p>(1) Participants will conduct a review of this product description in January 1999 under the consultation of paragraph 3 of the Declaration.</p>	<p><u>84716090</u></p>
<p>* Optical disc storage units for automatic data processing machines (including CD drives and DVD-drives), whether or not having the capability of writing/recording as well as reading, whether or not in their own housings.</p>	<p><u>84717051</u></p>
<p>* Paging alert devices and parts thereof.</p>	<p><u>85279092, 85299040</u></p>

<i>Description</i>	<i>HS 97 Headings</i>
* Plotters whether input or output units of HS heading No 8471 or drawing or drafting machines of HS heading No 9017.	<u>84716090, 84718090,</u> <u>90171010, 90172005</u>
* Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.	<u>84732110, 84732910,</u> <u>84733010, 84735010,</u> <u>85175090, 85179082,</u> <u>85299040</u>
* Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, Zipdrive cartridge storage units.	<u>84717051, 84717053,</u> <u>84717059, 84717060,</u> <u>84717090, 85232011,</u> <u>85232019, 85232090,</u> <u>85244091, 85244099,</u> <u>85249190</u>
* Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones, as well as a printed circuit assembly that enables the ADP machine and units thereof to process audio signals (sound cards).	<u>85438979</u>
* Set top boxes which have communication function a microprocessor-based device incorporating a modem for gaining access to the Internet, and having a function of interactive information exchange.	<u>85175090, 85438977</u>

## Vorschlag

Beschluß des Rates

97/0083 (ACC)

### über die Beseitigung der Zölle auf bestimmte Spirituosen

DER RAT DER EUROPÄISCHEN UNION -

gestützt auf den Vertrag zur Gründung der Europäischen Gemeinschaft, insbesondere auf Artikel 113 in Verbindung mit Artikel 228 Absatz 2 Satz 1,

auf Vorschlag der Kommission,

in der Erwägung, daß die Beseitigung der Zölle durch die Vereinigten Staaten von Amerika und die Europäische Gemeinschaft im allgemeinen Interesse liegen dürfte -

BESCHLIESST:

#### *Artikel 1*

Das Abkommen in Form einer Vereinbarung zwischen der Europäischen Gemeinschaft und den Vereinigten Staaten von Amerika über Spirituosen wird im Namen der Gemeinschaft genehmigt.

Der Wortlaut des Abkommens ist diesem Beschluß beigefügt.

#### *Artikel 2*

Der Rat ermächtigt die Kommission, der Welthandelsorganisation die im Anhang beigefügte Änderung der Liste der Europäischen Gemeinschaft zu übermitteln, um die Zölle auf die betreffenden Spirituosen zu binden und zu beseitigen.

#### *Artikel 3*

Der Präsident des Rates wird ermächtigt, die Person zu bestellen, die befugt ist, das Abkommen/Protokoll rechtsverbindlich für die Gemeinschaft zu unterzeichnen.

Geschehen zu Brüssel

Im Namen des Rates

Der Präsident

## VEREINBARUNG

### ex 2208 Branntwein, Likör und andere Spirituosen

Wir haben, wie in Singapur vereinbart, eingehende Verhandlungen über den Abbau der Zölle auf bestimmte Spirituosen geführt.

Vorbehaltlich des Abschlusses der jeweiligen internen Verfahren senken die Europäische Gemeinschaft und die Vereinigten Staaten von Amerika ihre am 1. Juli 1997 geltenden Zölle auf die Waren der nachstehenden Positionen des Harmonisierten Systems 1996 in vier gleichen Raten am 1. Juli 1997, am 1. Januar 1998, am 1. Januar 1999 und am 1. Januar 2000 bis zum vollständigen Zollabbau. Davon ausgenommen ist Rum (Position 2208 40), für den die im Anhang niedergelegten besonderen Bestimmungen gelten.

#### HS 96

2208 20	Branntwein aus Wein oder Traubentrester
2208 30	Whisky
2208 50	Gin und Genever
2208 60	Wodka
2008 70	Likör

ex 2208 90 andere als Ethylalkohol mit einem Alkoholgehalt von weniger als 80 % vol, unvergällt (Positionen 2208 90 91 und 2208 90 99 in der Europäischen Gemeinschaft und Position 2208 90 80 in den Vereinigten Staaten von Amerika)

## ANHANG

**Betreff: 2208 40 - Rum und Taffia**

**A. EG Zölle**

1. Die Zölle auf Rum mit einem Gehalt an anderen flüchtigen Stoffen als Ethyl- und Methylalkohol von 225 Gramm je Hektoliter reinen Alkohols oder mehr (Toleranzschwelle von 10 %) werden wie folgt gesenkt:

<b>In Behältnissen mit einem Inhalt von 2 Litern oder weniger</b>	<b>In Behältnissen mit einem Inhalt von mehr als 2 Litern</b>
Ausgangszollsatz 0,8 Ecu/%vol/hl + 4,1 Ecu/hl	0,8 Ecu/ %vol/hl
1. Juli 1997 0,8 Ecu/ %vol/hl + 4,1 Ecu/hl	0,8 Ecu/ %vol/hl
1. Juli 1998 0,7 Ecu/ %vol/hl +3,8 Ecu/hl	0,7 Ecu/ %vol/hl
1. Juli 1999 0,65 Ecu/ %vol/hl +3,5 Ecu/hl	0,65 Ecu/ %vol/hl
1. Juli 2000 0,6 Ecu %vol/hl + 3,2 Ecu/hl	0,6 Ecu/%vol/hl

2. Für Rum und Taffia mit dem in der nachstehenden Tabelle angegebenen Wert, die nicht unter die Warenbezeichnung in Absatz 1 fallen, gelten in der EG im Rahmen der nachstehenden Zollkontingente die jeweils angegebenen ermäßigten Zollsätze, bis am 1. Januar 2003 Zollfreiheit gewährt wird. Die Zollkontingente gelten für Rum in Behältnissen beliebiger Größe.



	Zollsatz		Zollkontingent
	In Behältnissen mit einem Inhalt von 2 Litern oder weniger und mit einem Wert von mehr als 7,9 Ecu je Liter reinen Alkohols	In Behältnissen mit einem Inhalt von mehr als 2 Litern und mit einem Wert von mehr als 2,0 Ecu je Liter reinen Alkohols	Liter reinen Alkohols
1. Juli 1997	0,7 Ecu/ %vol/hl +3,5 Ecu/hl	0,7 Ecu/%vol/hl	890 000
1. Januar 1998	0,6 Ecu/ %vol/hl + 2,9 Ecu/hl	0,6 Ecu/%vol/hl	1 950 000
1. Januar 1999	0,5 Ecu/%vol/hl + 2,3 Ecu/hl	0,5 Ecu/%vol/hl	2 145 000
1. Januar 2000	0,4 Ecu/ %vol/hl +1,8 Ecu/hl	0,4 Ecu/%vol/hl	2 359 500
1. Januar 2001	0,3 Ecu/ %vol/hl +1,2 Ecu/hl	0,3 Ecu/%vol/hl	2 595 450
1. Januar 2002	0,2 Ecu/ %vol/hl +0,6 Ecu/hl	0,2 Ecu/%vol/hl	2 854 995
Ab 1. Januar 2003	frei	frei	unbegrenzt

3. Für Rum und Taffia unterhalb der obengenannten Wertgrenze sowie für Rum und Taffia, die nicht unter die Zollkontingente fallen, gelten die in Absatz 1 genannten Zollsätze.
4. Die Europäische Gemeinschaft notifiziert den Vereinigten Staaten von Amerika unverzüglich alle zwischen dem 1. Januar 2000 und dem 1. Januar 2003 eintretenden Änderungen bei der Präferenzbehandlung ihrer Rumeinfuhren. Die Europäische Gemeinschaft nimmt auf Antrag unverzüglich Konsultationen mit den Vereinigten Staaten von Amerika über Angelegenheiten im Zusammenhang mit den unter Absatz 2 fallenden Rumausfuhren der Vereinigten Staaten von Amerika in die Gemeinschaft auf, um eine für beide Seiten zufriedenstellende Lösung für alle bei den Konsultationen angesprochenen Fragen zu finden.

**B. Zölle der Vereinigten Staaten von Amerika**

5. Die Zölle auf Rum und Taffia werden wie folgt gesenkt:

	Rum und Taffia	Rum und Taffia
	(a) in Behältnissen mit einem Inhalt von 4 Litern oder weniger und mit einem Wert von mehr als 3,00 USD je "Proof"-Liter; und  (b) in Behältnissen mit einem Inhalt von mehr als 4 Litern und einem Wert von mehr als 69 Cents je "Proof"-Liter	(a) in Behältnissen mit einem Inhalt von 4 Litern oder weniger und einem Wert von 3,00 USD je "Proof"-Liter oder weniger; und  (b) in Behältnissen mit einem Inhalt von mehr als 4 Litern und einem Wert von 69 Cents je "Proof"-Liter oder weniger
1. Juli 1997	26,1 Cents/"Proof"-Liter	30,4 Cents/"Proof"-Liter
1. Januar 1998	21,7 Cents/"Proof"-Liter	28,1 Cents/"Proof"-Liter
1. Januar 1999	17,4 Cents/"Proof"-Liter	25,9 Cents/"Proof"-Liter
1. Januar 2000	13,0 Cents/"Proof"-Liter	23,7 Cents/"Proof"-Liter
1. Januar 2001	8,7 Cents/"Proof"-Liter	23,7 Cents/"Proof"-Liter
1. Januar 2002	4,3 Cents/"Proof"-Liter	23,7 Cents/"Proof"-Liter
1. Januar 2003	frei	23,7 Cents/"Proof"-Liter

## EC - SPIRITS - Schedule CXL

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 97	Jan. 98	Jan. 99	Jan. 2000
2208	Udenatured ethyl alcohol of an alcoholic strength by volume of less than 80 % vol; spirits, liqueurs and other spirituous beverages						
2208 20	- Spirits obtained by distilling grape wine or grape marc						
	-- In containers holding 2 litres or less						
2208 20 12	--- Cognac	1.12 Ecu/% vol/hl + 7 Ecu/hl	free	0.84 Ecu/% vol/hl + 5.3 Ecu/hl	0.56 Ecu/% vol/hl + 3.5 Ecu/hl	0.28 Ecu/% vol/hl + 1.8 Ecu/hl	free
2208 20 14	--- Armagnac	1.12 Ecu/% vol/hl + 7 Ecu/hl	free	0.84 Ecu/% vol/hl + 5.3 Ecu/hl	0.56 Ecu/% vol/hl + 3.5 Ecu/hl	0.28 Ecu/% vol/hl + 1.8 Ecu/hl	free
2208 20 26	--- Grappa	1.12 Ecu/% vol/hl + 7 Ecu/hl	free	0.84 Ecu/% vol/hl + 5.3 Ecu/hl	0.56 Ecu/% vol/hl + 3.5 Ecu/hl	0.28 Ecu/% vol/hl + 1.8 Ecu/hl	free
2208 20 27	--- Brandy de Jerez	1.12 Ecu/% vol/hl + 7 Ecu/hl	free	0.84 Ecu/% vol/hl + 5.3 Ecu/hl	0.56 Ecu/% vol/hl + 3.5 Ecu/hl	0.28 Ecu/% vol/hl + 1.8 Ecu/hl	free
2208 20 29	--- Other	1.12 Ecu/% vol/hl + 7 Ecu/hl	free	0.84 Ecu/% vol/hl + 5.3 Ecu/hl	0.56 Ecu/% vol/hl + 3.5 Ecu/hl	0.28 Ecu/% vol/hl + 1.8 Ecu/hl	free
	-- In containers holding more than 2 litres						
2208 20 40	--- Raw distillate	1.12 Ecu/% vol/hl	free	0.84 Ecu/% vol/hl	0.56 Ecu/% vol/hl	0.28 Ecu/% vol/hl	free
	--- Other						
2208 20 62	--- Cognac	1.12 Ecu/% vol/hl	free	0.84 Ecu/% vol/hl	0.56 Ecu/% vol/hl	0.28 Ecu/% vol/hl	free
2208 20 64	--- Armagnac	1.12 Ecu/% vol/hl	free	0.84 Ecu/% vol/hl	0.56 Ecu/% vol/hl	0.28 Ecu/% vol/hl	free
2208 20 86	--- Grappa	1.12 Ecu/% vol/hl	free	0.84 Ecu/% vol/hl	0.56 Ecu/% vol/hl	0.28 Ecu/% vol/hl	free
2208 20 87	--- Brandy de Jerez	1.12 Ecu/% vol/hl	free	0.84 Ecu/% vol/hl	0.56 Ecu/% vol/hl	0.28 Ecu/% vol/hl	free

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*EC - SPIRITS - Schedule CXL*

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 97	Jan. 98	Jan. 99	Jan. 2000
2208 20 89	-- Other	1.12 Ecu/% vol/hl	free	0.84 Ecu/% vol/hl	0.56 Ecu/% vol/hl	0.28 Ecu/% vol/hl	free
2208 30	- Whiskies						
	-- Bourbon whiskey, in containers holding						
2208 30 11	-- 2 litres or less	0.2 Ecu/% vol/hl + 1.5 Ecu/hl	free	0.15 Ecu/% vol/hl + 1.13 Ecu/hl	0.1 Ecu/% vol/hl + 0.8 Ecu/hl	0.05 Ecu/% vol/hl + 0.8 Ecu/hl	free
2208 30 19	--- More than 2 litres	0.2 Ecu/% vol/hl	free	0.15 Ecu/% vol/hl	0.1 Ecu/% vol/hl	0.05 Ecu/% vol/hl	free
	-- Scotch whisky						
	--- Malt whisky, in containers holding						
2208 30 32	-- 2 litres or less	0.28 Ecu/% vol/hl + 2.1 Ecu/hl	free	0.21 Ecu/% vol/hl + 1.6 Ecu/hl	0.14 Ecu/% vol/hl + 1.1 Ecu/hl	0.07 Ecu/% vol/hl + 0.5 Ecu/hl	free
2208 30 38	-- More than 2 litres	0.28 Ecu/% vol/hl	free	0.21 Ecu/% vol/hl	0.14 Ecu/% vol/hl	0.07 Ecu/% vol/hl	free
	-- Blended whisky, in containers holding						
2208 30 52	-- 2 litres or less	0.28 Ecu/% vol/hl + 2.1 Ecu/hl	free	0.21 Ecu/% vol/hl + 1.6 Ecu/hl	0.14 Ecu/% vol/hl + 1.1 Ecu/hl	0.07 Ecu/% vol/hl + 0.5 Ecu/hl	free
2208 30 58	--- More than 2 litres	0.28 Ecu/% vol/hl	free	0.21 Ecu/% vol/hl	0.14 Ecu/% vol/hl	0.07 Ecu/% vol/hl	free
	--- Other, in containers holding						
2208 30 72	--- 2 litres or less	0.28 Ecu/% vol/hl + 2.1 Ecu/hl	free	0.21 Ecu/% vol/hl + 1.6 Ecu/hl	0.14 Ecu/% vol/hl + 1.1 Ecu/hl	0.07 Ecu/% vol/hl + 0.5 Ecu/hl	free
2208 30 78	-- More than 2 litres	0.28 Ecu/% vol/hl	free	0.21 Ecu/% vol/hl	0.14 Ecu/% vol/hl	0.07 Ecu/% vol/hl	free
	-- Other, in containers holding						
2208 30 82	--- 2 litres or less	0.28 Ecu/% vol/hl + 2.1	free	0.21 Ecu/% vol/hl + 1.6	0.14 Ecu/% vol/hl + 1.1	0.07 Ecu/% vol/hl + 0.5	free

## EC - SPIRITS - Schedule CXL

CN 97	Label	Base	Final Bound	Implementation			
		Rate	Rate	Jul. 97	Jan. 99	Jan. 99	Jan. 2000
		Ecu/hl		Ecu/hl	Ecu/hl	Ecu/hl	
2208 30 88	--- More than 2 litres	0.28 Ecu/% vol/hl	free	0.21 Ecu/% vol/hl	0.14 Ecu/% vol/hl	0.07 Ecu/% vol/hl	free
2208 40	- Rum and taffia:						
2208 40 10	-- In containers holding 2 litres or less						
	--- Ex: Rum with a content of volatile substances other than ethyl and methyl alcohol equal to or exceeding 225 grams per hectolitre of pure alcohol with a 10% tolerance.	0.8 Ecu/% vol/hl					
		+ 4.1 Ecu/hl					
	--- Ex: Other	0.8 Ecu/% vol/hl					
		+ 4.1 Ecu/hl					
2208 40 90	-- In containers holding more than 2 litres						
	--- Ex: Rum with a content of volatile substances other than ethyl and methyl alcohol equal to or exceeding 225 grams per hectolitre of pure alcohol with a 10% tolerance.	0.8 ECU/% vol/hl					
	--- Ex: Other	0.8 Ecu/% vol/hl					
2208 50	- Gin and geneva:						
	-- Gin, in containers holding						
2208 50 11	--- 2 litres or less	0.8 Ecu/% vol/hl	free	0.6 Ecu/% vol/hl	0.4 Ecu/% vol/hl	0.2 Ecu/% vol/hl	free
		+ 4.1 Ecu/hl		+ 3.1 Ecu/hl	+ 2.1 Ecu/hl	+ 1.0 Ecu/hl	
2208 50 19	--- More than 2 litres	0.8 Ecu/% vol/hl	free	0.6 Ecu/% vol/hl	0.4 Ecu/% vol/hl	0.2 Ecu/% vol/hl	free
	-- Geneva, in containers holding						
2208 50 91	--- 2 litres or less	1.3 Ecu/% vol/hl	free	1.0 Ecu/% vol/hl	0.7 Ecu/% vol/hl	0.3 Ecu/% vol/hl	free
		+ 8.2 Ecu/hl		+ 6.2 Ecu/hl	+ 4.1 Ecu/hl	+ 2.1 Ecu/hl	
2208 50 99	--- More than 2 litres	1.3 Ecu/% vol/hl	free	1.0 Ecu/% vol/hl	0.7 Ecu/% vol/hl	0.3 Ecu/% vol/hl	free
2208 60	- Vodka						
	-- Of an alcoholic strength by volume of 45.4% vol or less in containers holding						
2208 60 11	--- 2 litres or less	1.1 Ecu/%	free	0.8 Ecu/%	0.6 Ecu/%	0.3 Ecu/%	free

EC - SPIRITS - Schedule CXL

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CN 97	Label	Base Rate	Final Bound rate	Implementation						
				July 1997	July 1998	July 1999	July 2000	Jan 2001	Jan 2002	Jan 2003
2208 40	- Rum and taffia									
2208 40 10	-- In containers holding 2 litres or less --- Ex: Rum with a content of volatile substances other than ethyl and methyl alcohol equal to or exceeding 225 grams per hectolitre of pure alcohol with a 10% tolerance	0.8 Ecu/%vol/hl + 4.1 Ecu/hl	0.6 Ecu/%vol/hl + 3.2 Ecu/hl	0.8 Ecu/%vol/hl + 4.1 Ecu/hl	0.7 Ecu/%vol/hl + 3.8 Ecu/hl	0.65 Ecu/%vol/hl + 3.5 Ecu/hl	0.6 Ecu/%vol/hl + 3.2 Ecu/hl			
	--- Ex Other: ---- Valued over Ecu 7.9 per litre of 100% alcohol*	0.8 Ecu/%vol/hl + 4.1 Ecu/hl	Free	0.7 Ecu/%vol/hl + 3.5 Ecu/hl*	0.6 Ecu/%vol/hl + 2.9 Ecu/hl*	0.5 Ecu/%vol/hl + 2.3 Ecu/hl*	0.4 Ecu/%vol/hl + 1.8 Ecu/hl*	0.3 Ecu/%vol/hl + 1.2 Ecu/hl*	0.2 Ecu/%vol/hl + 0.6 Ecu/hl*	Free
	---- Other	0.8 Ecu/%vol/hl + 4.1 Ecu/hl	0.6 Ecu/%vol/hl + 3.2 Ecu/hl	0.8 Ecu/%vol/hl + 4.1 Ecu/hl	0.7 Ecu/%vol/hl + 3.8 Ecu/hl	0.65 Ecu/%vol/hl + 3.5 Ecu/hl	0.6 Ecu/%vol/hl + 3.2 Ecu/hl			
2208 40 90	-- In containers holding 2 litres or less --- Ex: Rum with a content of volatile substances other than ethyl and methyl alcohol equal to or exceeding 225 grams per hectolitre of pure alcohol with a 10% tolerance	0.8 Ecu/%vol/hl	0.6 Ecu/%vol/hl	0.8 Ecu/%vol/hl	0.7 Ecu/%vol/hl*	0.65 Ecu/%vol/hl	0.6 Ecu/%vol/hl			
	--- Ex Other: ---- Valued over Ecu 2.0 per litre of 100% alcohol*	0.8 Ecu/%vol/hl	Free	0.7 Ecu/%vol/hl*	0.6 Ecu/%vol/hl*	0.5 Ecu/%vol/hl*	0.4 Ecu/%vol/hl*	0.3 Ecu/%vol/hl*	0.2 Ecu/%vol/hl*	Free
	---- Other	0.8 Ecu/%vol/hl	0.6 Ecu/%vol/hl	0.8 Ecu/%vol/hl	0.7 Ecu/%vol/hl	0.65 Ecu/%vol/hl	0.6 Ecu/%vol/hl			

\* Note: In the period 1 July 1997 to 31 December 2002 these concessions shall be limited by the tariff quota amounts indicated below within which rum and taffia in whatever size of container can be imported at the duty rates indicated. From 1 January 2003 there will be no tariff quota limitation:

Period	Tariff Quota	Litres of 100% alcohol	Period	Tariff Quota	Litres of 100% alcohol	Period	Tariff Quota	Litres of 100% alcohol
1 July 1997 - 31 December 1997		890,000	1 Jan 1999 - 31 December 1999		2,145,000	1 Jan 2001 - 31 December 2001		2,595,450
1 Jan 1998 - 31 December 1998		1,950,000	1 Jan 2000 - 31 December 2000		2,359,500	1 Jan 2002 - 31 December 2002		2,854,995

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## EC - SPIRITS - Schedule CXL

CN 97	Label	Base	Final Bound	Implementation			
		Rate	Rate	Jul. 97	Jan. 98	Jan. 99	Jan. 2000
		vol/hl +4.1 Ecu/hl		vol/hl +3.1 Ecu/hl	vol/hl +2.1 Ecu/hl	vol/hl +1.0 Ecu/hl	
2208 60 19	--- More than 2 litres	1.1 Ecu/% vol/hl	free	0.8 Ecu/% vol/hl	0.6 Ecu/% vol/hl	0.3 Ecu/% vol/hl	free
2208 60 91	-- Of an alcoholic strength by volume of more than 45.4% vol in containers holding: --- 2 litres or less	1.3 Ecu/% vol/hl +8.2 Ecu/hl	free	1.0 Ecu/% vol/hl +6.2 Ecu/hl	0.7 Ecu/% vol/hl +4.1 Ecu/hl	0.3 Ecu/% vol/hl +2.1 Ecu/hl	free
2208 60 99	--- More than 2 litres	1.3 Ecu/% vol/hl	free	1.0 Ecu/% vol/hl	0.7 Ecu/% vol/hl	0.3 Ecu/% vol/hl	free
2208 70	- Liqueurs and cordials in containers holding:						
2208 70 10	-- 2 litres or less	1.3 Ecu/% vol/hl +8.2 Ecu/hl	free	1.0 Ecu/% vol/hl +6.2 Ecu/hl	0.7 Ecu/% vol/hl +4.1 Ecu/hl	0.3 Ecu/% vol/hl +2.1 Ecu/hl	free
2208 70 90	-- More than 2 litres	1.3 Ecu/% vol/hl	free	1.0 Ecu/% vol/hl	0.7 Ecu/% vol/hl	0.3 Ecu/% vol/hl	free
2208 90	- Other						
2208 90 11	-- Arrack, in containers holding: --- 2 litres or less	0.8 Ecu/% vol/hl +4.1 Ecu/hl	free	0.6 Ecu/% vol/hl +3.1 Ecu/hl	0.4 Ecu/% vol/hl +2.1 Ecu/hl	0.2 Ecu/% vol/hl +1.0 Ecu/hl	free
2208 90 19	--- More than 2 litres	0.8 Ecu/% vol/hl	free	0.6 Ecu/% vol/hl	0.4 Ecu/% vol/hl	0.2 Ecu/% vol/hl	free
2208 90 33	-- Plum, pear or cherry spirit (excluding liqueurs), in containers holding: --- 2 litres or less	0.91 Ecu/% vol/hl + 3.5 Ecu/hl	free	0.68 Ecu/% vol/hl + 2.6 Ecu/hl	0.46 Ecu/% vol/hl + 1.8 Ecu/hl	0.22 Ecu/% vol/hl + 0.9 Ecu/hl	free
2208 90 38	--- More than 2 litres	1.1 Ecu/% vol/hl	free	0.8 Ecu/% vol/hl	0.6 Ecu/% vol/hl	0.3 Ecu/% vol/hl	free
	-- Other spirits, and other spirituous beverages, in containers holding: --- 2 litres or less						



## EC - SPIRITS - Schedule CXL

CN 97	Label	Base Rate	Final Bound Rate	Implementation			
				Jul. 97	Jan. 99	Jan. 99	Jan. 2000
2208 90 41	--- Ouzo	1.3 Ecu/% vol/hl +8.2 Ecu/hl	free	1.0 Ecu/% vol/hl +6.2 Ecu/hl	0.7 Ecu/% vol/hl +4.1 Ecu/hl	0.3 Ecu/% vol/hl +2.1 Ecu/hl	free
	--- Other						
	--- Spirits (excluding liqueurs)						
	--- Distilled from fruit						
2208 90 45	--- Calvados	1.12 Ecu/% vol/hl + 7 Ecu/hl	free	0.84 Ecu/% vol/hl + 5.3 Ecu/hl	0.56 Ecu/% vol/hl + 3.5 Ecu/hl	0.28 Ecu/% vol/hl + 1.8 Ecu/hl	free
2208 90 48	--- Other	1.12 Ecu/% vol/hl + 7 Ecu/hl	free	0.84 Ecu/% vol/hl + 5.3 Ecu/hl	0.56 Ecu/% vol/hl + 3.5 Ecu/hl	0.28 Ecu/% vol/hl + 1.8 Ecu/hl	free
	--- Other						
2208 90 52	--- Korn	1.3 Ecu/% vol/hl +8.2 Ecu/hl	free	1.0 Ecu/% vol/hl +6.2 Ecu/hl	0.7 Ecu/% vol/hl +4.1 Ecu/hl	0.3 Ecu/% vol/hl +2.1 Ecu/hl	free
2208 90 57	--- Other	1.3 Ecu/% vol/hl +8.2 Ecu/hl	free	1.0 Ecu/% vol/hl +6.2 Ecu/hl	0.7 Ecu/% vol/hl +4.1 Ecu/hl	0.3 Ecu/% vol/hl +2.1 Ecu/hl	free
2208 90 69	--- Other spiritual beverages	1.3 Ecu/% vol/hl +8.2 Ecu/hl	free	1.0 Ecu/% vol/hl +6.2 Ecu/hl	0.7 Ecu/% vol/hl +4.1 Ecu/hl	0.3 Ecu/% vol/hl +2.1 Ecu/hl	free
	--- More than 2 litres						
	--- Spirits (excluding liqueurs)						
	--- Distilled from fruit						
2208 90 71	--- Distilled from fruit	1.12 Ecu/% vol/hl	free	0.84 Ecu/% vol/hl	0.56 Ecu/% vol/hl	0.28 Ecu/% vol/hl	free
2208 90 74	--- Other	1.3 Ecu/% vol/hl	free	1.0 Ecu/% vol/hl	0.7 Ecu/% vol/hl	0.3 Ecu/% vol/hl	free
2208 90 78	--- Other spiritual beverages	1.3 Ecu/% vol/hl	free	1.0 Ecu/% vol/hl	0.7 Ecu/% vol/hl	0.3 Ecu/% vol/hl	free



## FINANZBOGEN

1. Vorschlag für einen Beschluß des Rates über die Beseitigung der Zölle auf Waren der Informationstechnologie und auf bestimmte Spirituosen
2. Haushaltlinie: Kapitel 12/Artikel 120
3. Rechtsgrundlage: Artikel 113
4. Beschreibung der Maßnahme: Der Vorschlag geht zurück auf den Beschluß des Rates über die Aufnahme von Verhandlungen mit Drittländern über den Abschluß eines Übereinkommens über die Informationstechnologie und auf die politische Verpflichtung, die die Minister am 13. Dezember 1996 auf der Ministerkonferenz in Singapur eingegangen sind.  
Er betrifft die Beseitigung der Zölle auf Waren der Informationstechnologie und auf bestimmte Spirituosen bis zum Jahr 2000.
5. Art der Einnahmeverluste: Zölle auf Einfuhren aus Drittländern
6. Änderung der Höhe der Einnahmen: Die Einfuhrzölle auf Waren der Informationstechnologie sollen in vier gleichen Raten vom 1. Juli 1997 bis zum 1. Januar 2000 beseitigt werden. Die Einnahmeverluste wurden anhand der Differenz zwischen den in der Uruguay-Runde vereinbarten Zollsätzen (für die jeweiligen Kalenderjahre) und den im Rahmen des ITA vereinbarten Zollsätzen (für die entsprechenden Kalenderjahre) berechnet, wobei das Einfuhrvolumen des Jahres 1995 zugrunde gelegt wurde (siehe Anhang). Die Einnahmeverluste entsprechen also lediglich den zusätzlichen Mindereinnahmen. Auf dieser Grundlage ergeben sich folgenden Einnahmeverluste:  
  
1.7.97: 242,6 MECU  
1.1.98: 643,3 MECU  
1.1.99: 891,3 MECU  
1.1.2000: 1.241,8 MECU

Im Falle der Spirituosen ergeben sich ausgehend von den Einfuhren in die Fünfzehnergemeinschaft im Jahre 1995 und unter Zugrundelegung der Wertäquivalente

für alle Einfuhren aus den Ländern mit Meistbegünstigungsstatus in diesem Jahr folgende Zollmindereinnahmen:

1.7.97: 0,5 MECU

1.1.98: 1,6 MECU

1.1.99: 2 MECU

1.1.2000: 2,5 MECU

1.1.2001: 1,9 MECU

1.1.2002: 1,2 MECU

1.1.2003: 0,7 MECU

Die durchschnittlichen jährlichen Einnahmeverluste belaufen sich auf 1,625 MECU und insgesamt auf 10,5 MECU (über einen Zeitraum von 6,5 Jahren).

Die Einnahmeverluste bei den traditionellen Eigenmitteln werden durch zusätzliche BSP-Eigenmittel finanziert.

HS-97	EU imports 95 (kecu)	Total duty loss ITA	Duty loss 97 4 steps	Duty loss 98 4 steps	Duty loss 99 4 steps	Duty loss 00 4 steps
3818 00 Total	170 531	26 432	1 535	5 628	8 185	11 085
8469 11 Total	29 929	1 616	120	359	449	689
8470 10 Total	410 719	43 622	3 304	9 495	12 383	18 440
8470 21 Total	59 114	8 394	650	1 833	2 365	3 547
8470 29 Total	11 975	1 701	132	371	479	719
8470 30 Total	2 786	130	10	28	36	56
8470 40 Total	11 834	550	41	118	154	237
8470 50 Total	166 942	7 763	584	1 669	2 170	3 339
8470 90 Total	32 651	1 518	114	327	424	653
8471 10 Total	83 905	2 317	175	506	662	974
8471 30 Total	2 956 157	175 892	13 303	38 430	50 255	73 904
8471 41 Total	344 694	20 134	1 523	4 399	5 752	8 460
8471 49 Total	2 308 652	136 826	10 348	29 895	39 093	57 490
8471 50 Total	538 257	31 692	2 397	6 924	9 055	13 316
8471 60 Total	4 769 150	19 070	14 303	4 767	0	0
8471 70 Total	5 495 373	20 234	15 611	4 623	0	0
8471 80 Total	538 415	2 154	1 615	538	0	0
8471 90 Total	287 733	1 151	863	288	0	0
8472 90 Total	22 038	1 146	88	243	331	485
8473 21 Total	4 654	101	19	23	24	36
8473 29 Total	33 008	644	87	125	183	250
8473 30 Total	3 352 385	159 348	12 910	34 748	49 640	62 050
8473 50 Total	3 632 303	182 332	13 563	37 785	55 417	75 568
8504 40 Total	250 682	1 003	752	251	0	0
8504 50 Total	10 903	949	65	207	273	403
8517 11 Total	375 826	1 879	1 504	376	0	0
8517 19 Total	1 058 182	228 762	13 445	48 140	71 647	95 530
8517 21 Total	859 052	71 731	5 584	15 463	19 759	30 926
8517 22 Total	1 334	111	9	24	31	48
8517 30 Total	152 286	12 716	990	2 741	3 503	5 482
8517 50 Total	673 096	57 152	4 138	12 353	16 429	24 232
8517 80 Total	443 858	37 063	2 885	7 990	10 209	15 979
8517 90 Total	1 171 807	81 855	6 781	17 828	22 094	35 153
8518 10 Total	4 132	246	19	54	70	103
8518 29 Total	9 796	705	49	157	206	294
8518 30 Total	41 032	1 949	226	451	451	821
8520 20 Total	126 869	11 862	825	2 537	3 425	5 075
8523 11 Total	100 846	4 639	403	1 008	1 210	2 017
8523 12 Total	62 554	5 223	344	1 126	1 564	2 189
8523 13 Total	437 681	36 546	2 407	7 878	10 942	15 319
8523 20 Total	239 018	14 039	1 128	3 036	4 114	5 760
8523 90 Total	80 320	6 707	442	1 446	2 008	2 811
8524 31 Total	89 984	7 514	495	1 620	2 250	3 149
8524 32 Total	89 984	7 514	495	1 620	2 250	3 149
8524 39 Total	80 986	6 762	445	1 458	2 025	2 834
8524 40 Total	145 407	3 878	541	851	1 034	1 450
8524 91 Total	989 196	5 603	3 019	1 341	518	725
8524 99 Total	18 630	1 556	103	336	466	652
8525 10 Total	24 608	2 129	135	468	640	886
8525 20 Total	388 830	58 145	3 178	12 339	18 322	24 305
8525 40 Total	94 861	11 146	617	2 372	3 510	4 648
8527 90 Total	34 958	6 572	419	1 398	1 958	2 797
8529 10 Total	149 579	12 639	972	2 692	3 590	5 386
8529 90 Total	817 789	57 245	4 907	12 266	15 538	24 534
8531 20 Total	822 421	79 301	4 519	17 257	24 653	32 871
8531 90 Total	12 931	1 248	71	272	388	517
8532 10 Total	0	0	26	73	99	140
8532 21 Total	131 340	11 492	854	2 495	3 284	4 860
8532 22 Total	251 381	21 996	1 634	4 776	6 285	9 301
8532 23 Total	50 047	3 253	250	701	951	1 351
8532 24 Total	222 137	14 439	1 110	3 110	4 221	5 998
8532 25 Total	24 091	1 566	120	337	458	650
8532 29 Total	21 420	1 392	107	300	407	578

HS-97	EU imports 95 (kecu)	Total duty loss ITA	Duty loss 97 4 steps	Duty loss 98 4 steps	Duty loss 99 4 steps	Duty loss 00 4 steps
8532 30 Total	22 797	1 995	148	433	570	844
8532 90 Total	6 070	534	36	115	158	225
8533 10 Total	50 255	3 216	251	704	905	1 357
8533 21 Total	158 855	10 167	794	2 224	2 859	4 289
8533 29 Total	26 522	1 697	133	371	477	716
8533 31 Total	18 333	1 173	92	257	330	495
8533 39 Total	8 032	514	40	112	145	217
8533 40 Total	101 626	6 504	508	1 423	1 830	2 744
8533 90 Total	17 264	1 105	86	242	311	466
8534 00 Total	593 219	62 584	3 856	13 051	18 983	26 695
8536 50 Total	31 476	1 700	126	378	473	724
8536 90 Total	527 614	28 491	2 110	6 331	7 914	12 135
8541 10 Total	214 276	35 784	1 928	7 500	11 357	15 000
8541 21 Total	117 862	19 683	1 061	4 126	6 246	8 250
8541 29 Total	223 342	37 296	2 010	7 817	11 837	15 633
8541 30 Total	27 227	4 547	245	953	1 443	1 906
8541 40 Total	283 283	21 013	1 495	4 456	6 465	8 597
8541 50 Total	16 154	2 698	145	565	856	1 131
8541 60 Total	328 696	30 569	2 301	6 574	8 546	13 148
8541 90 Total	41 665	2 854	229	625	792	1 208
8542 12 Total	86 358	28 714	1 511	6 045	9 068	12 090
8542 13 Total	3 297 950	191 806	13 183	39 569	59 918	79 137
8542 14 Total	216 715	25 841	1 640	5 361	8 119	10 723
8542 19 Total	3 518 982	218 368	14 862	45 080	68 266	90 161
8542 30 Total	896 423	149 704	8 068	31 374	47 510	62 750
8542 40 Total	150 154	25 076	1 350	5 255	7 958	10 510
8542 50 Total	174 530	29 147	1 571	6 109	9 250	12 217
8542 90 Total	88 672	6 074	488	1 330	1 685	2 571
8543 81 Total	269 728	23 601	1 753	5 125	6 743	9 980
8543 89 Total	13 486	1 180	88	256	337	499
8544 41 Total	57 694	4 442	346	923	1 269	1 904
8544 49 Total	47 339	4 118	284	899	1 183	1 752
8544 51 Total	7 101	547	43	114	156	234
8544 70 Total	44 147	5 474	353	1 192	1 633	2 296
9001 10 Total	53 088	3 610	319	796	956	1 540
9009 12 Total	399 100	56 872	3 392	11 973	17 560	23 946
9009 21 Total	169 827	24 200	1 444	5 095	7 472	10 190
9009 90 Total	933 748	131 854	7 877	27 773	40 692	55 513
9026 10 Total	74 446	4 006	344	869	1 072	1 718
9026 20 Total	106 025	6 314	532	1 378	1 692	2 715
9026 80 Total	75 851	4 284	369	930	1 146	1 838
9026 90 Total	106 653	4 940	449	1 098	1 297	2 096
9027 20 Total	62 103	3 485	313	608	1 012	1 552
9027 30 Total	170 639	9 300	768	1 365	2 901	4 266
9027 50 Total	159 177	9 391	955	2 069	2 388	3 979
9027 80 Total	324 106	16 654	1 659	3 663	4 290	7 043
9027 90 Total	205 974	12 152	1 236	2 678	3 090	5 149
9030 40 Total	82 925	8 362	580	1 904	2 401	3 477
Grand Total	50 430 563	3 018 930	242 676	643 351	891 396	1 241 843



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